

In-situ Observation and Multiscale Three-dimensional Characterization Ta Tensile Samples

SAND2013-8942C

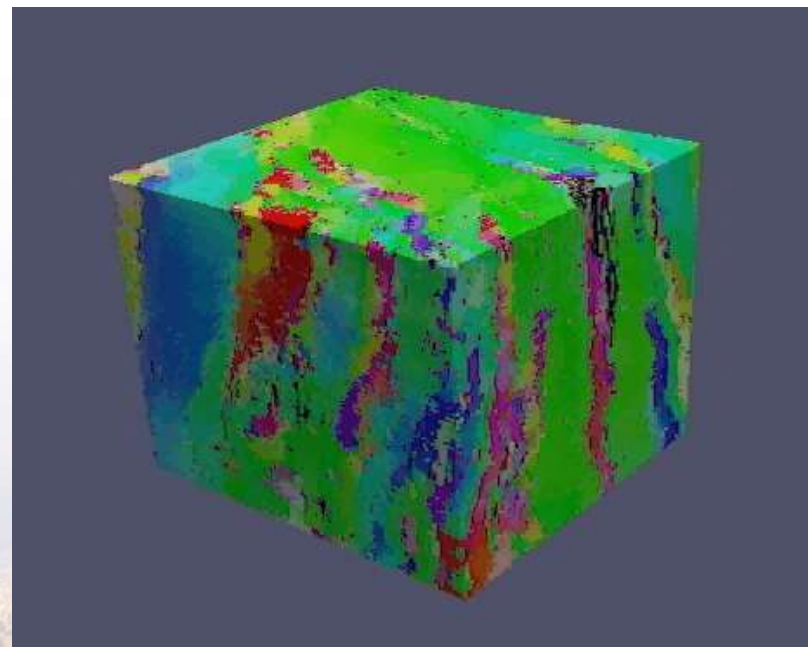
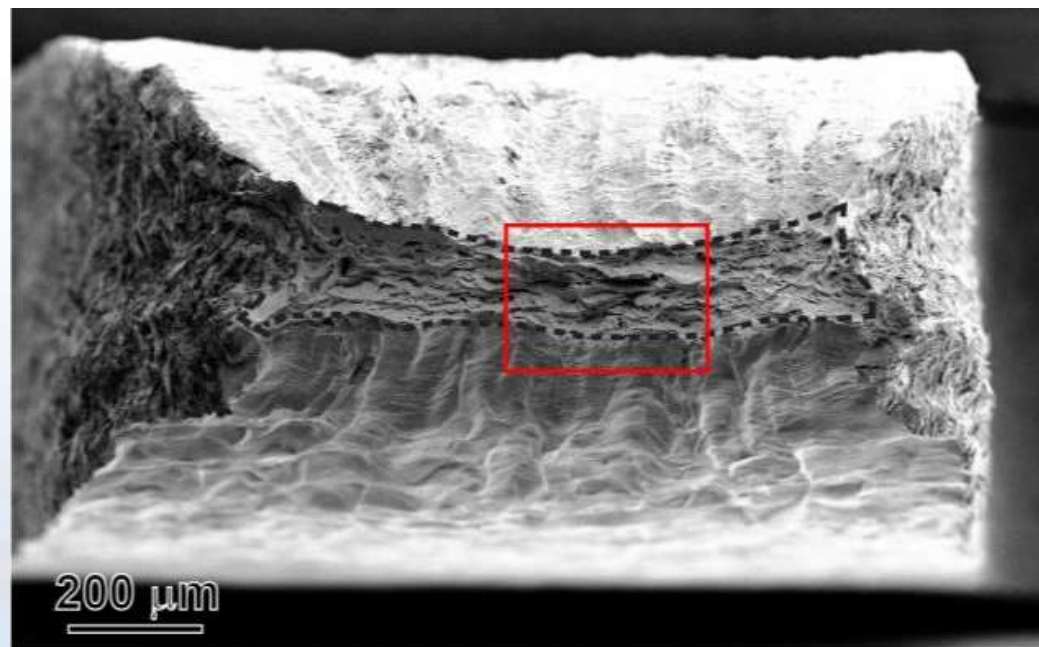
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Jonathan Madison, Joe Michael, and Brad Boyce

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October 28, 2013

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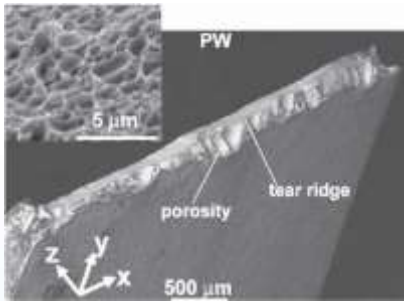
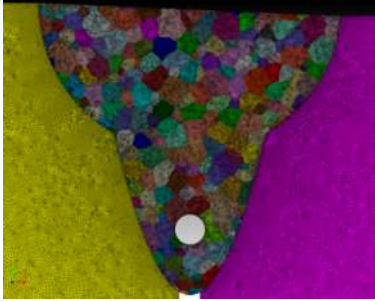


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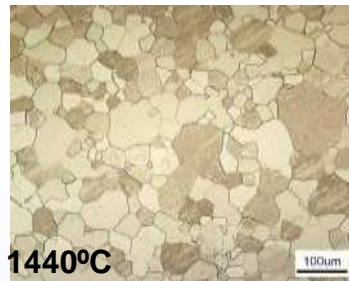
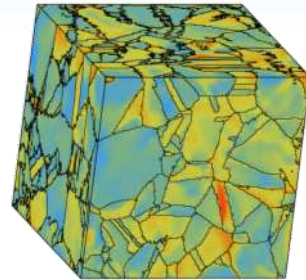
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Understanding Stochastic Deformation and Failure Requires Multiscale Experiments and Models



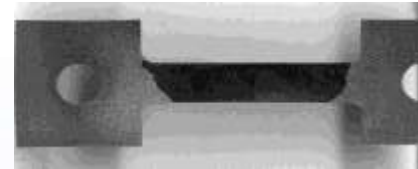
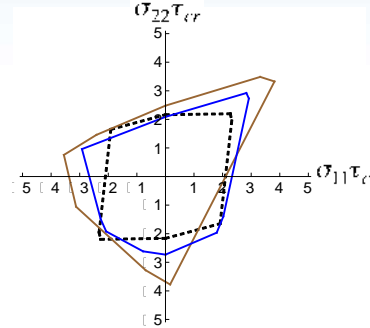
Material performance

$10^0 \text{ m } 10^6 \text{ s}$



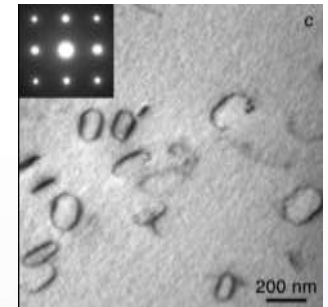
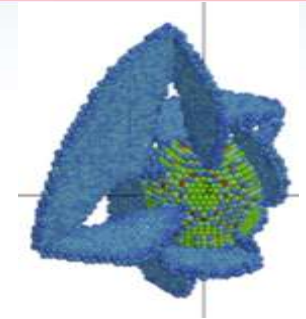
Microstructural effects

$10^{-3} \text{ m } 10^3 \text{ s}$



Single crystal behavior

$10^{-6} \text{ m } 10^0 \text{ s}$



Atomic scale phenomena

$10^{-9} \text{ m } 10^{-9} \text{ s}$

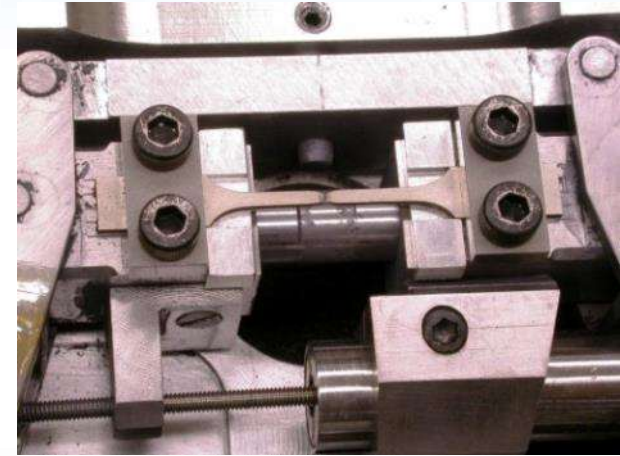
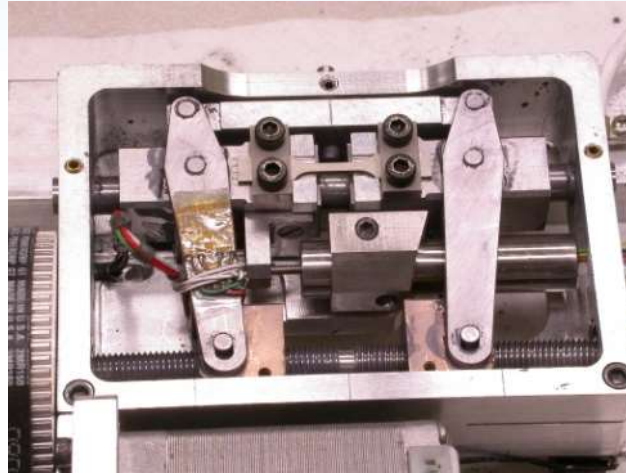
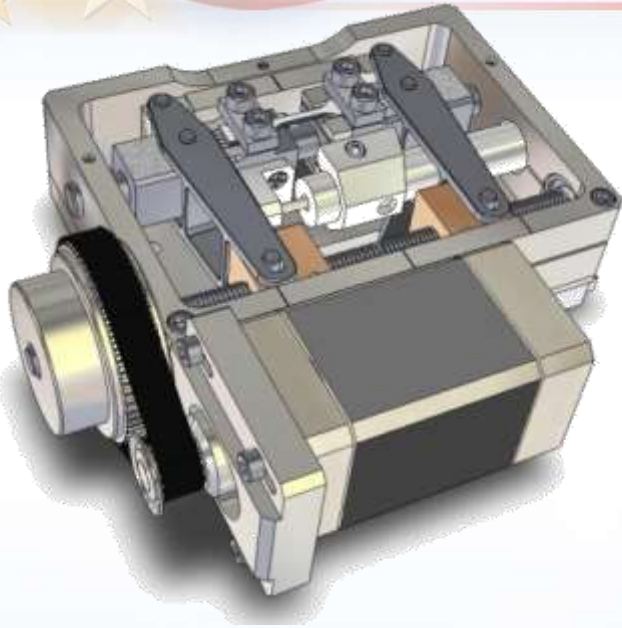
Atoms-up: Develop physics-based models to provide scientific insight

Continuum-down: Augment engineering-scale models to provide customer value



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Custom Compact In-situ SEM / EBSD Tensile Stage

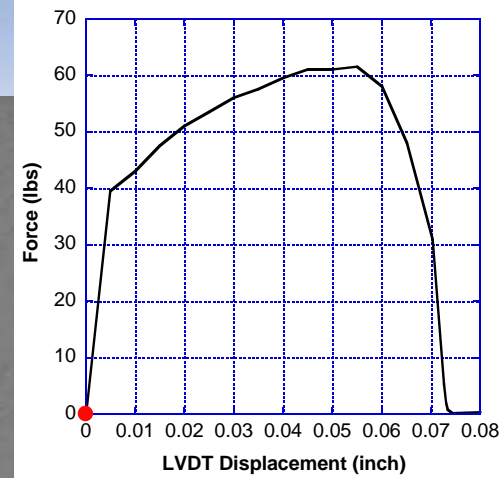
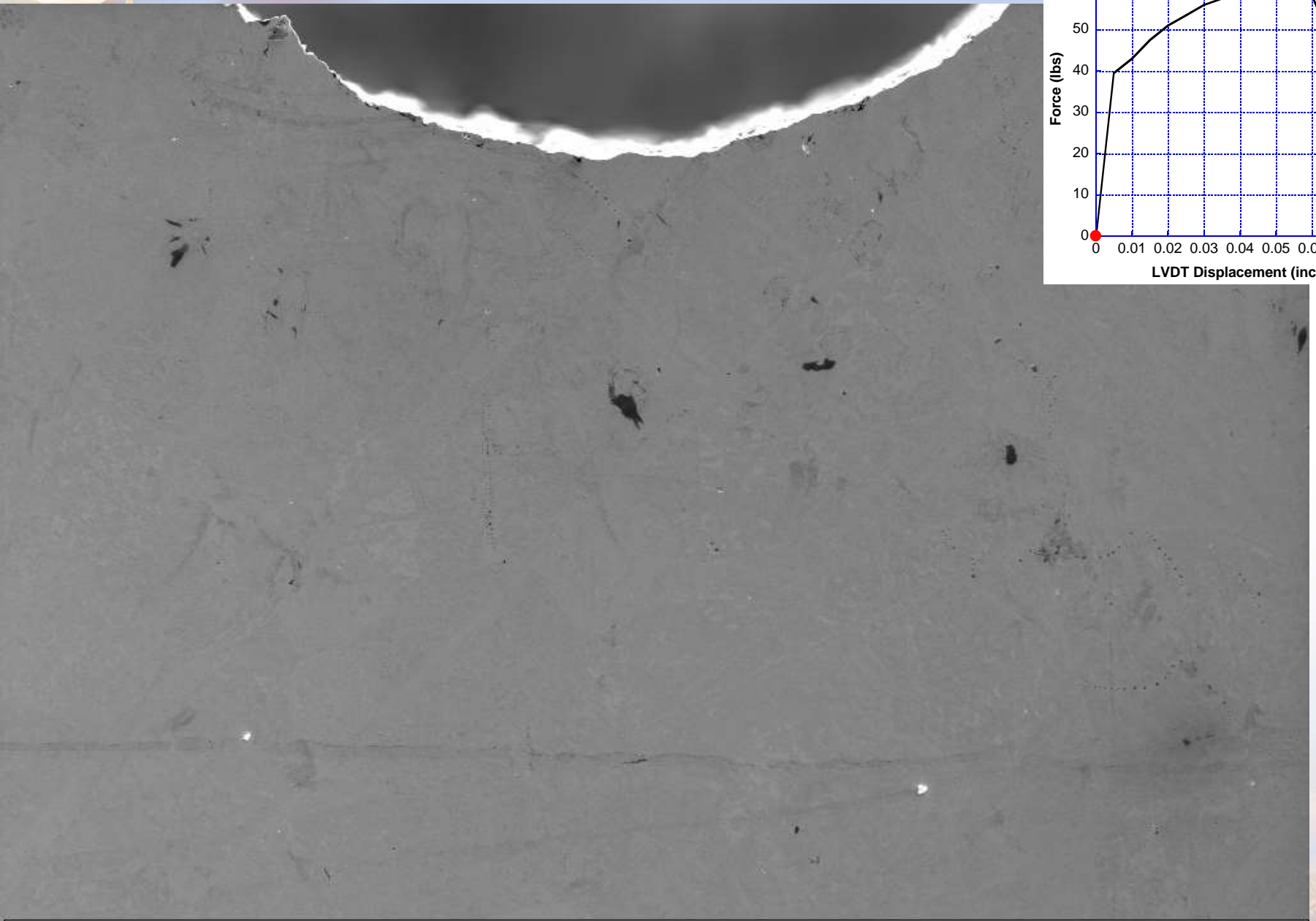


- Tensile stage with 2 kN capacity permits reasonable cross-section tensile bars (1 x 2 mm)
 - Compact size (~deck of cards) enables high-angle tilting for EBSD measurements.
- Speckling of tensile bars (~300 nm copper particles) allows simultaneous DIC measurements.
- Symmetric loading from both grips keeps the electrons on the center of the column.
 - Suitable for SEM or back-reflection x-ray

This capability permits real time characterization of the Ta sample during tensile deformation and failure



Observing Deformation in Tantalum



20 μ m

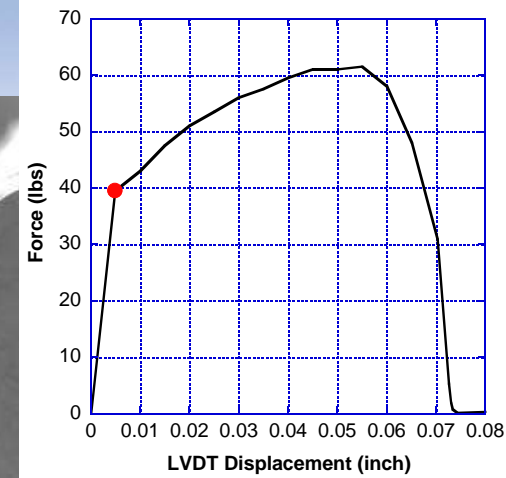
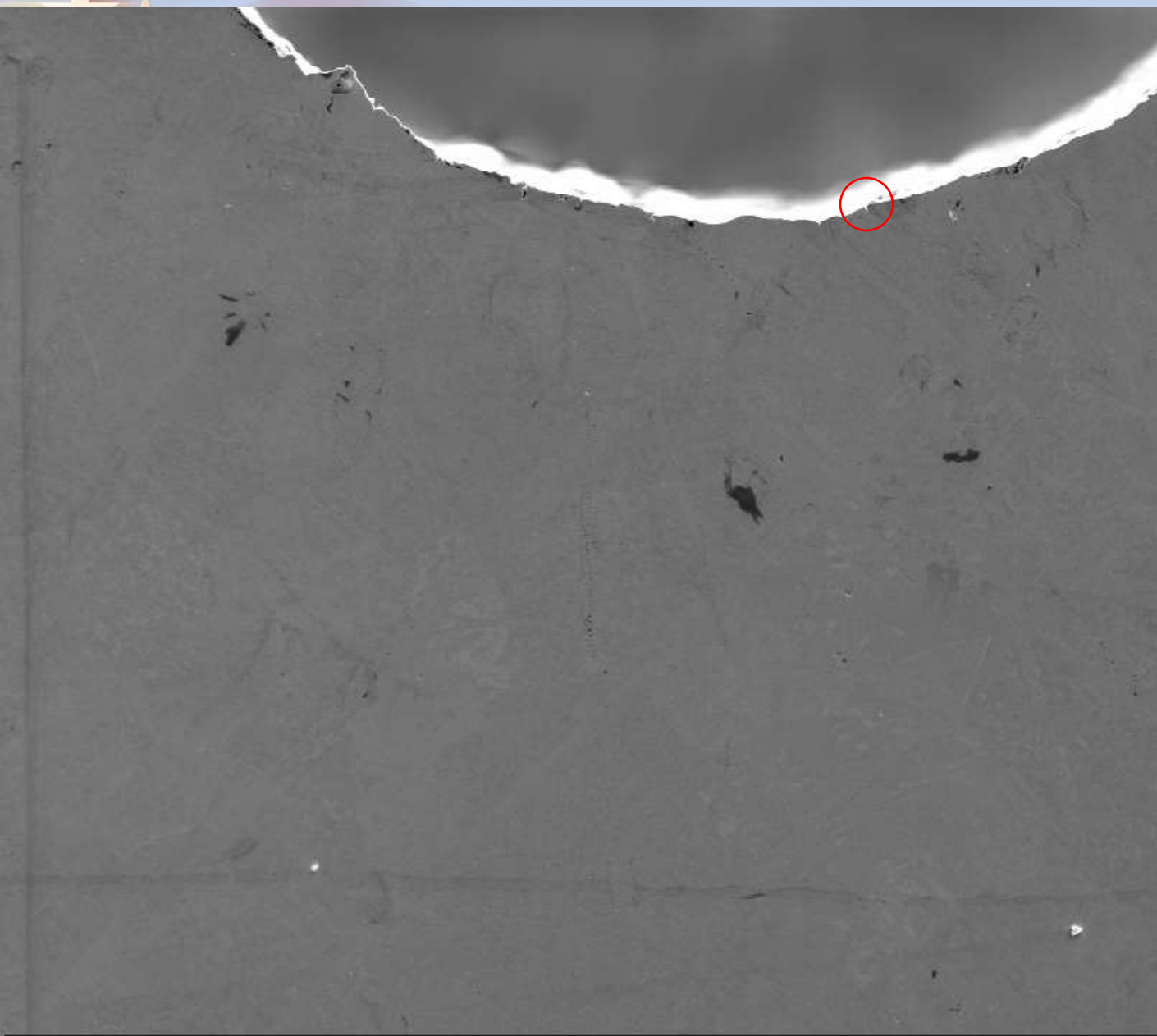
EHT = 10.00 kV

WD = 20.9 mm

Signal A = SE2

File Name = Ta-N1_d-553mV_02.tif

Observing Deformation in Tantalum



20 μ m

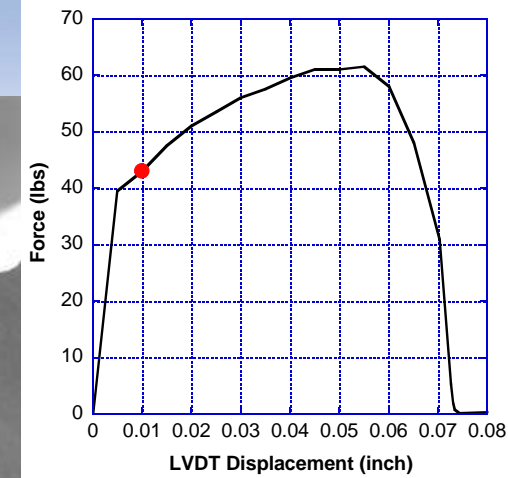
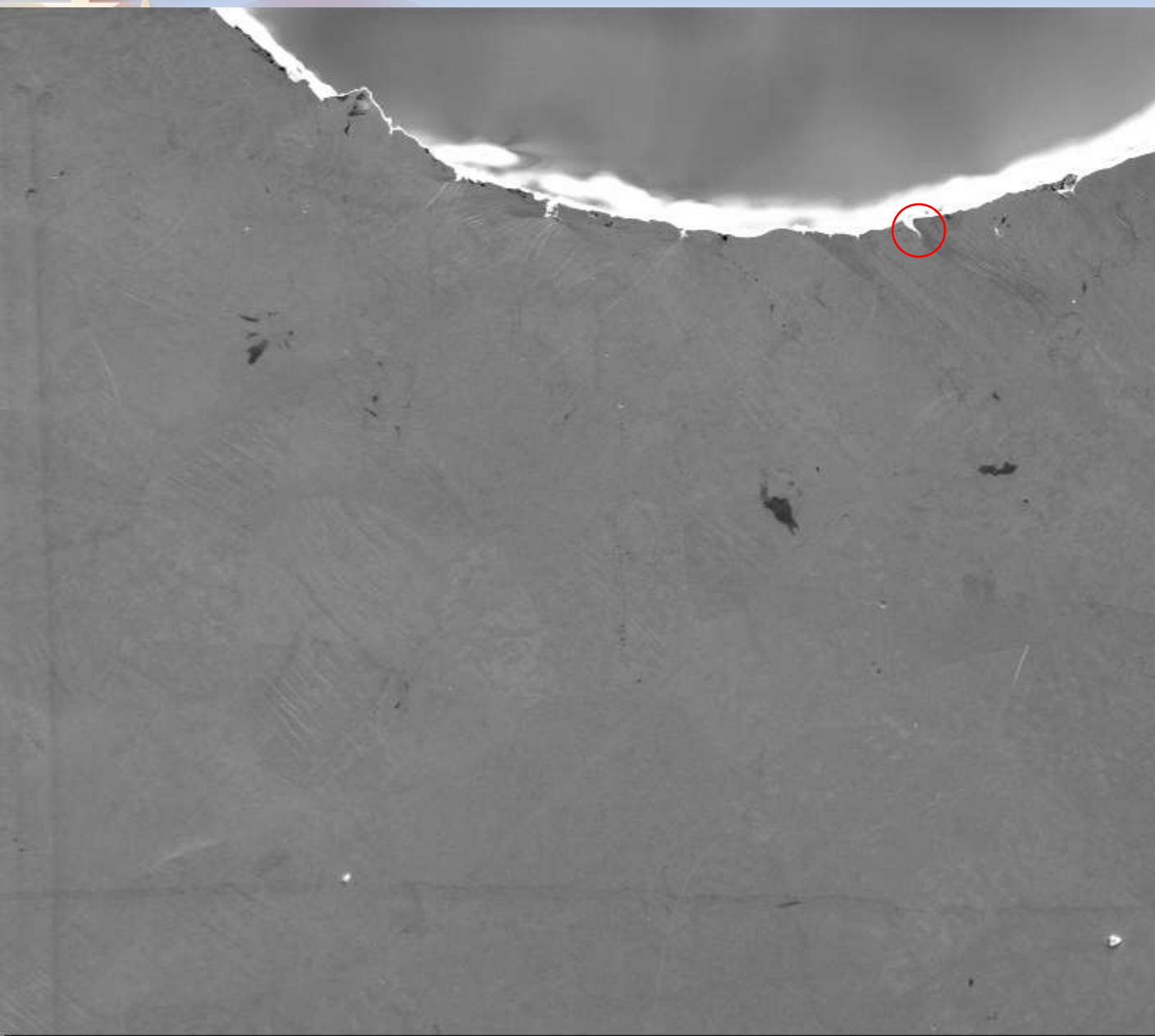
EHT = 10.00 kV

WD = 20.9 mm

Signal A = SE2

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Observing Deformation in Tantalum



20 μ m

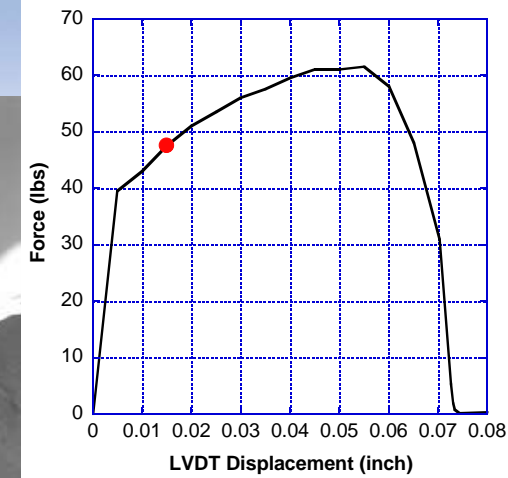
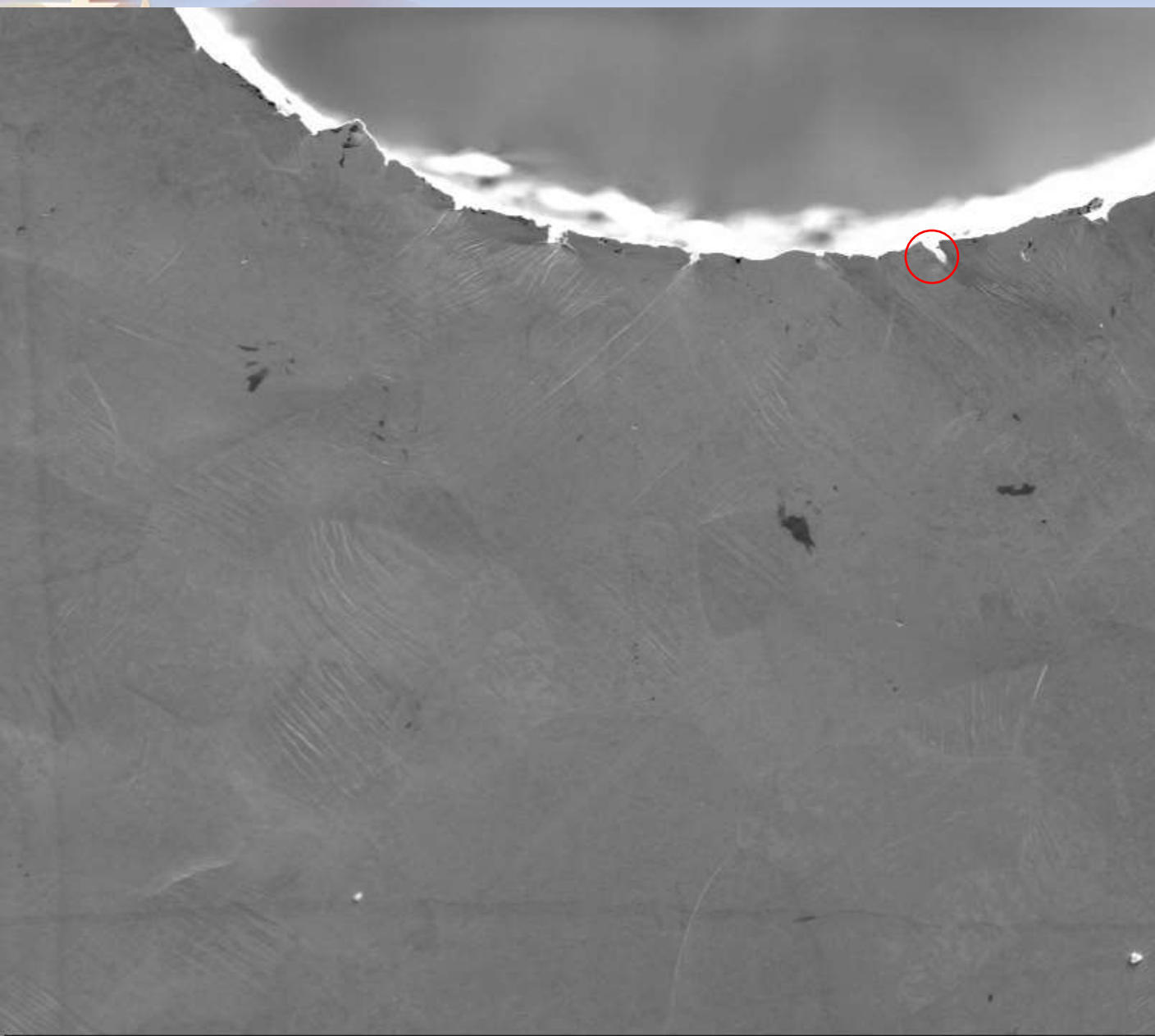
EHT = 10.00 kV

WD = 20.9 mm

Signal A = SE2

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Observing Deformation in Tantalum



20 μ m

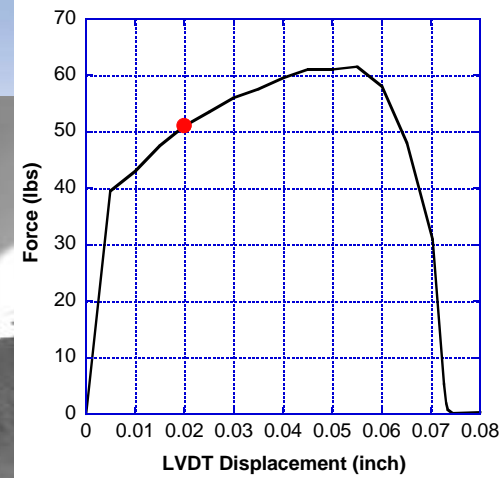
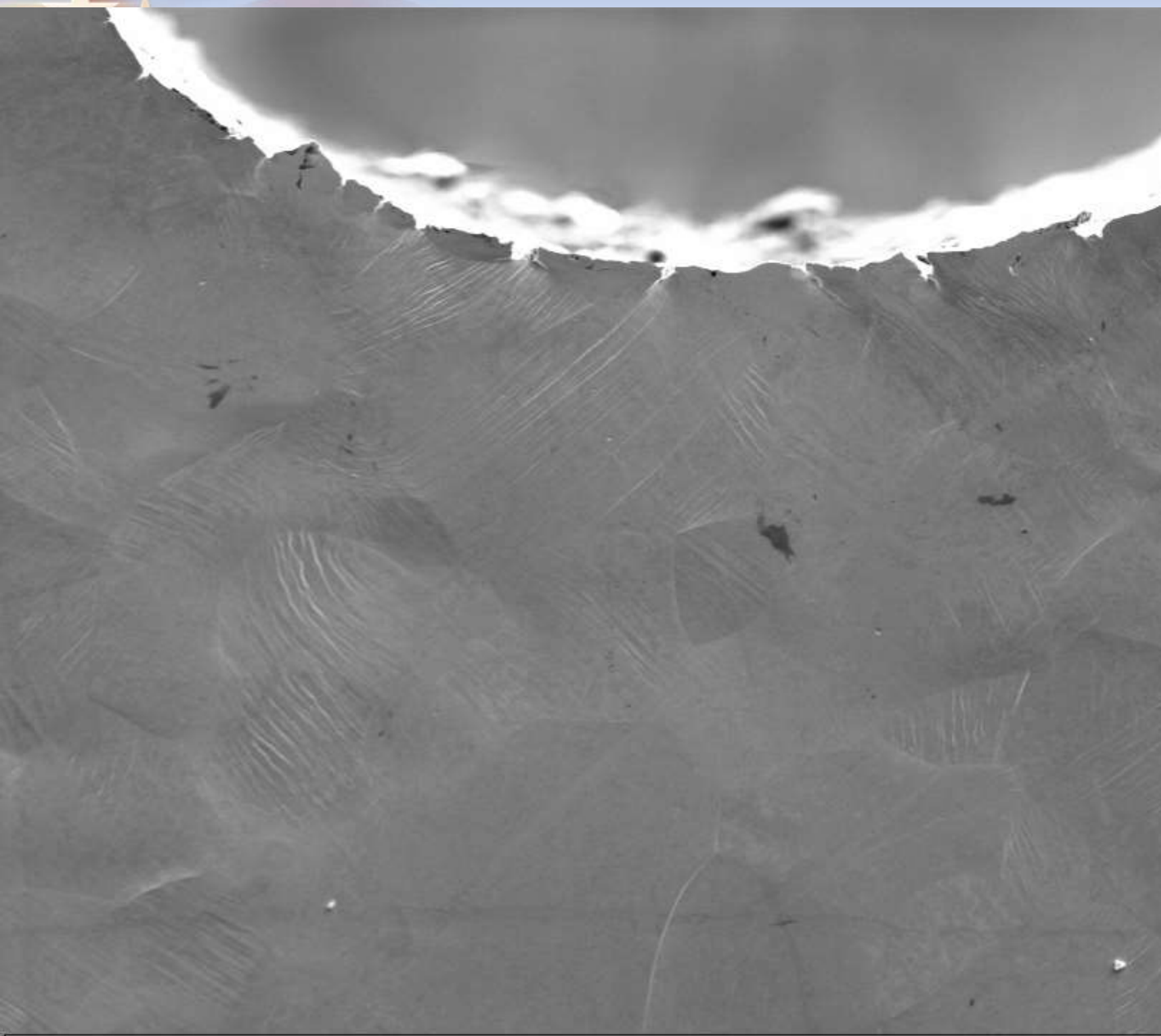
EHT = 10.00 kV

WD = 20.9 mm

Signal A = SE2

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Observing Deformation in Tantalum



20 μ m



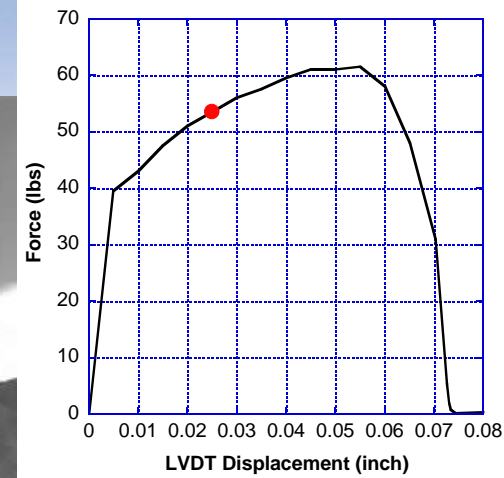
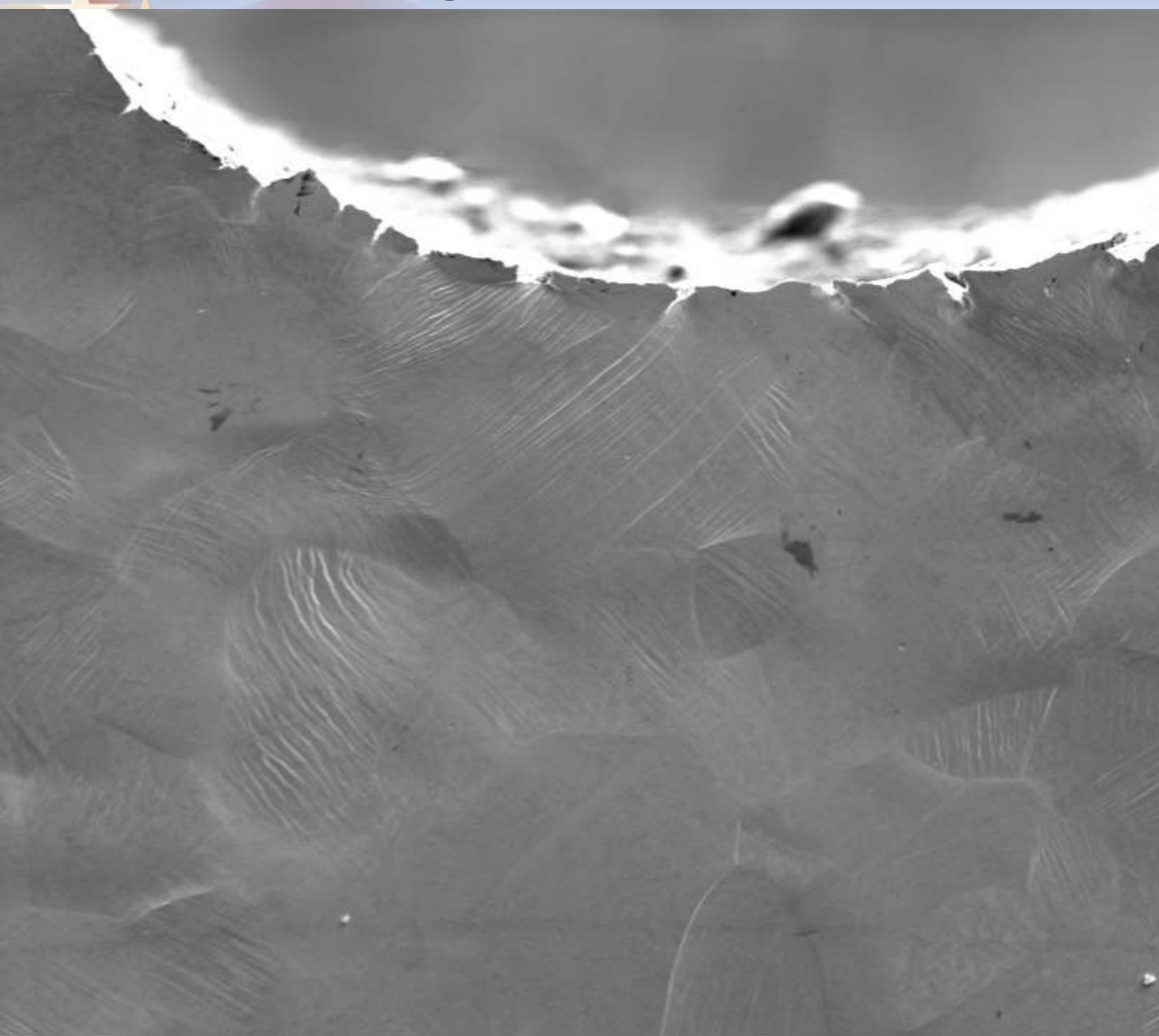
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WD = 20.9 mm

Signal A = SE2

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Observing Deformation in Tantalum



20 μm

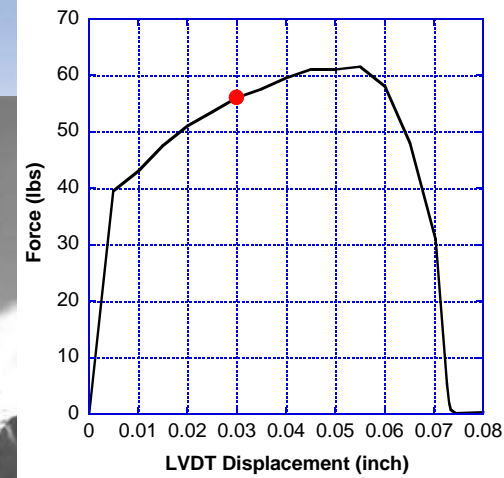
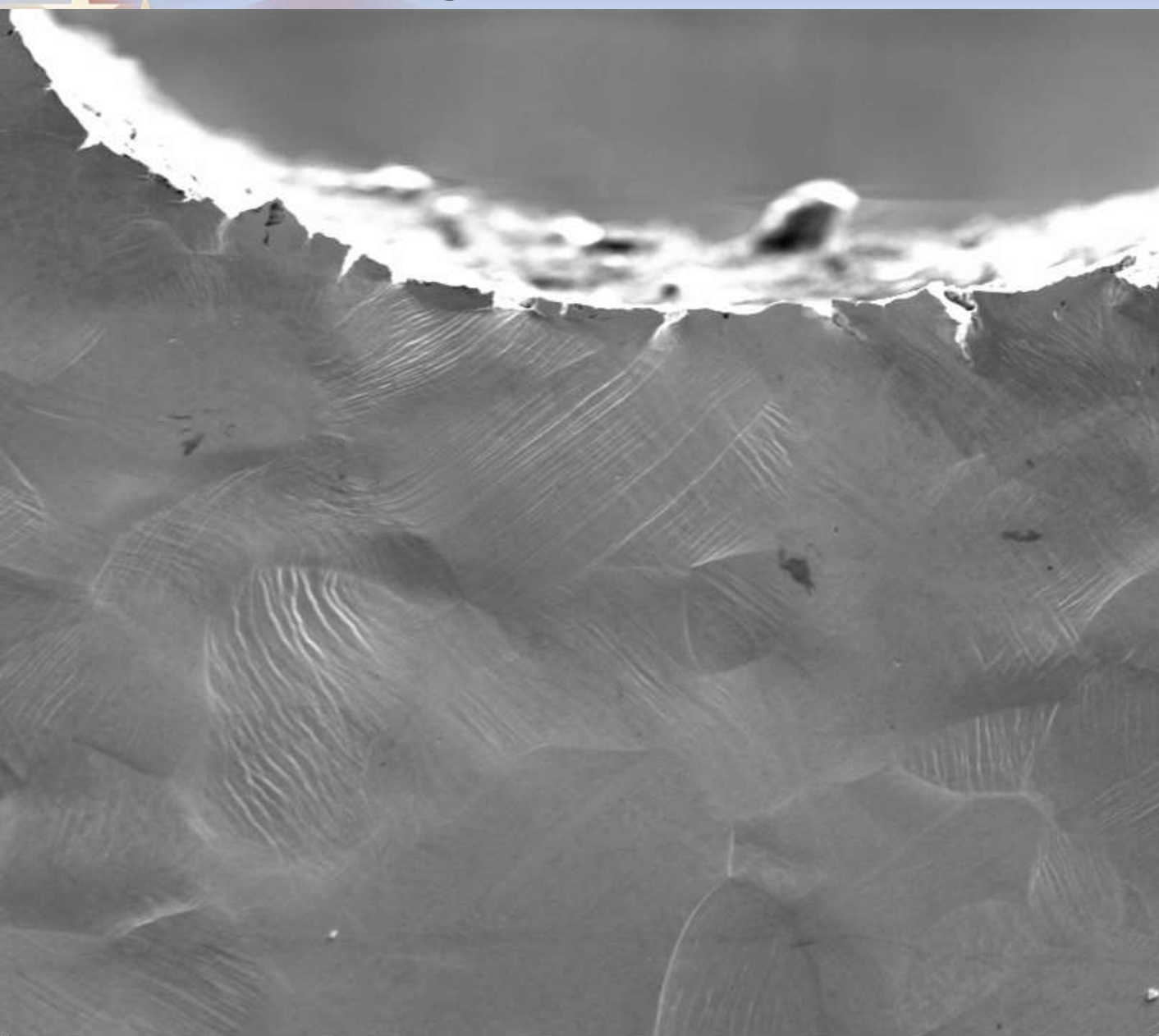
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WD = 20.9 mm

Signal A = SE2

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Observing Deformation in Tantalum



20 μm

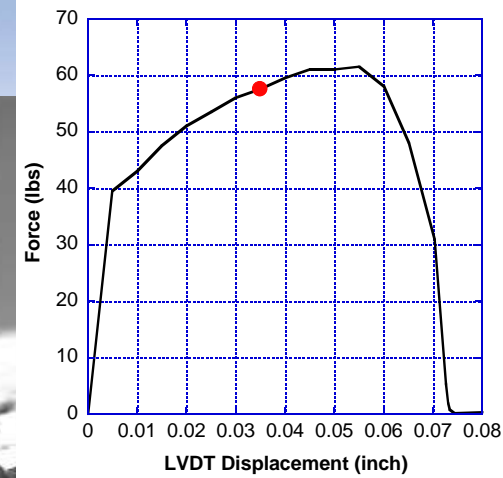
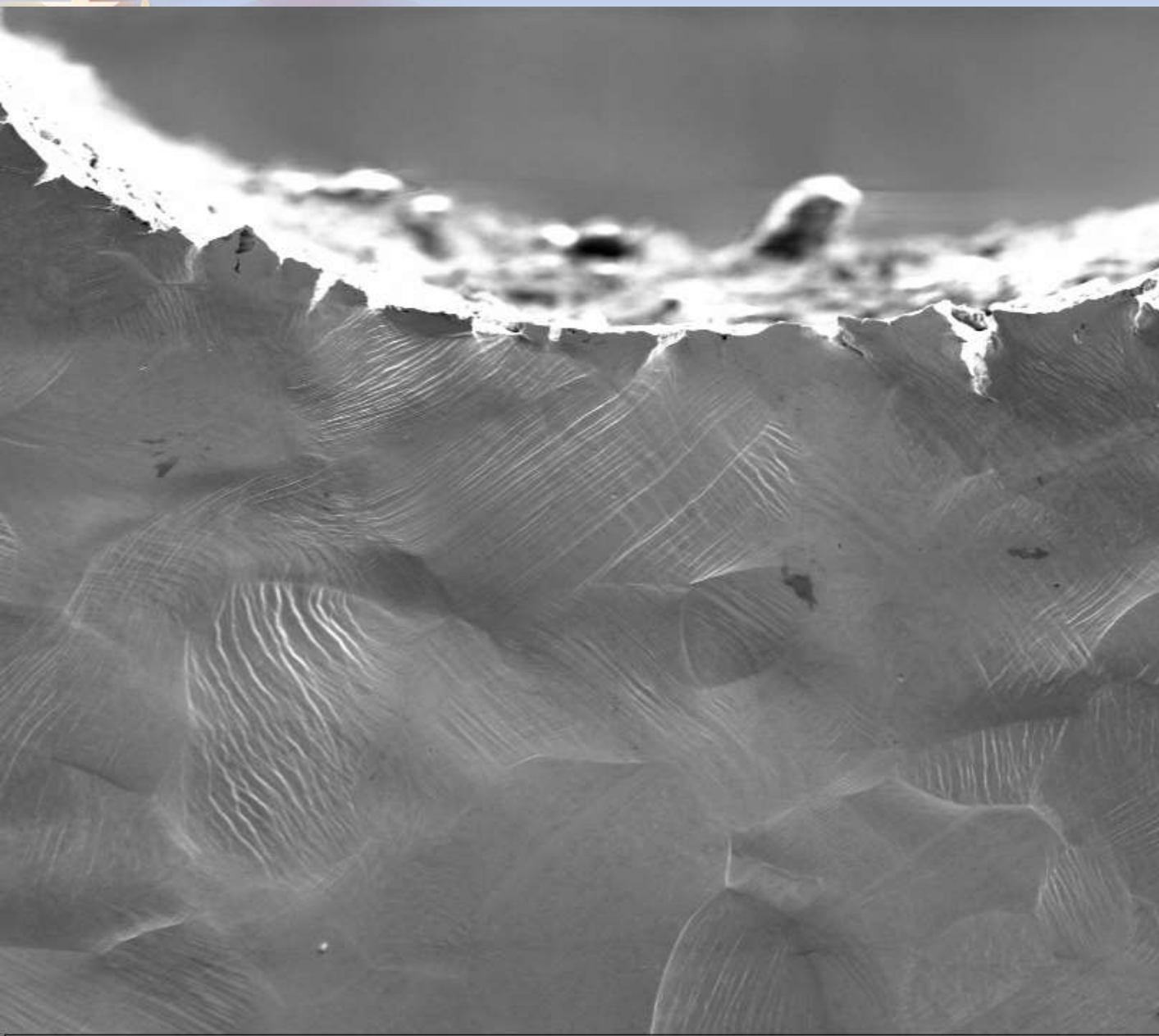
EHT = 10.00 kV

WD = 20.9 mm

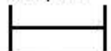
Signal A = SE2

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Observing Deformation in Tantalum



20 μ m



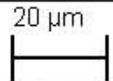
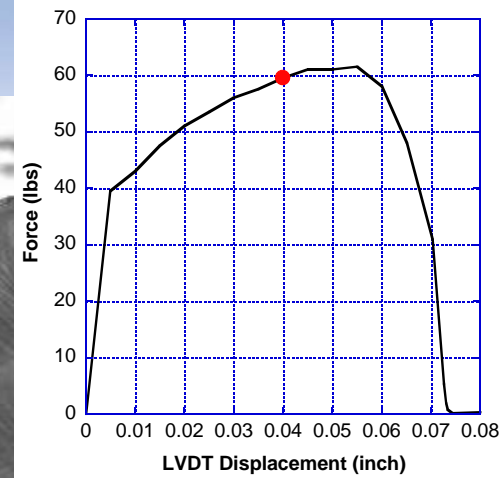
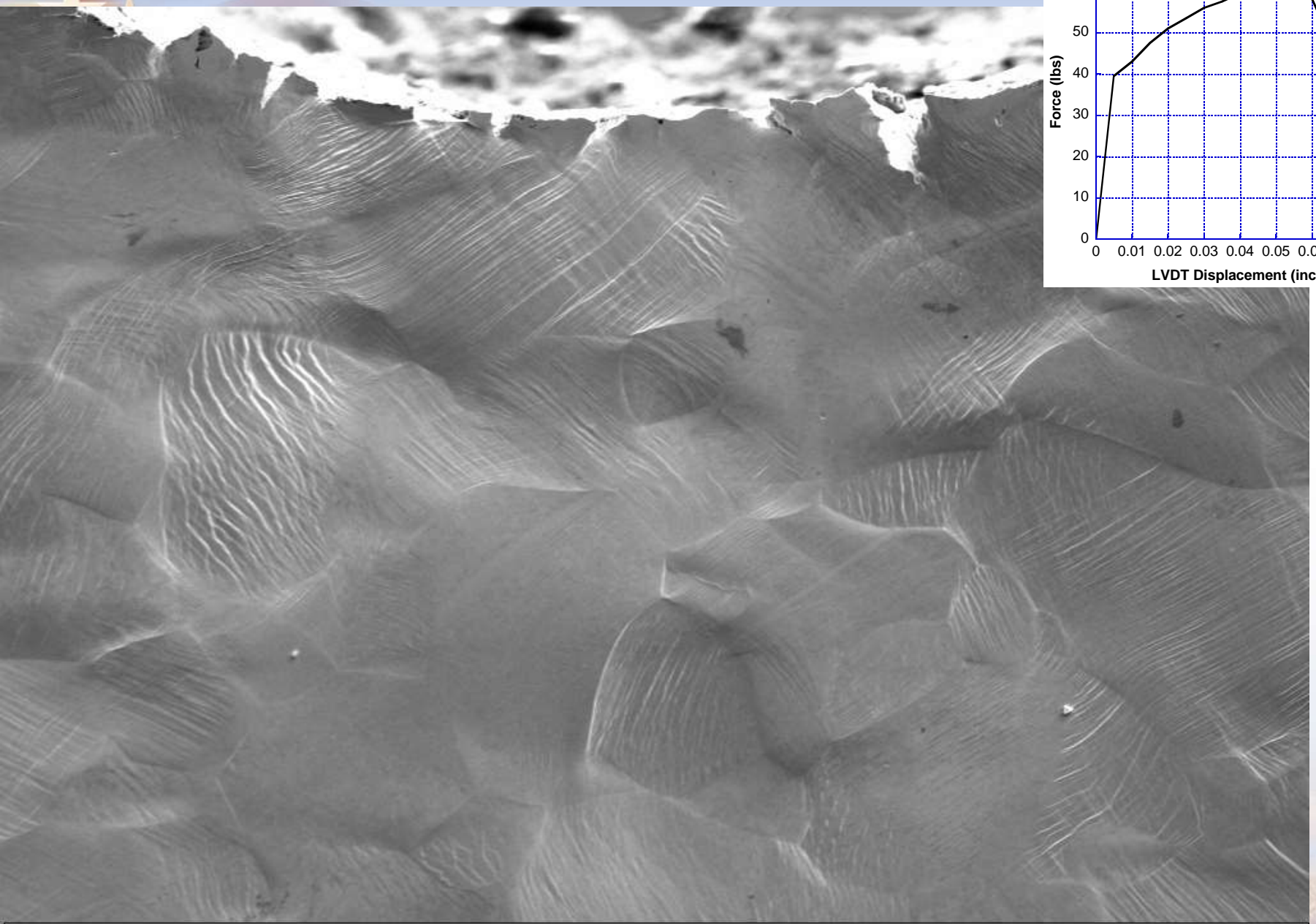
EHT = 10.00 kV

WD = 21.0 mm

Signal A = SE2

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Observing Deformation in Tantalum



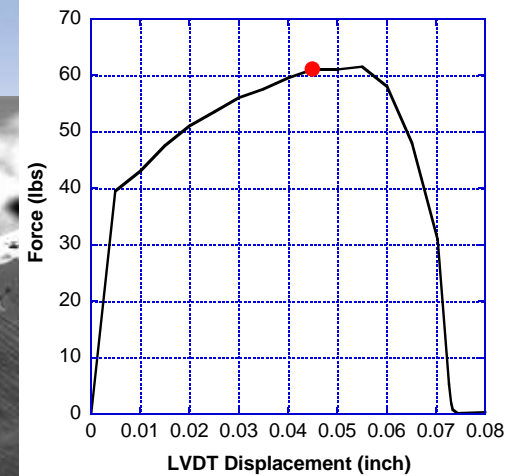
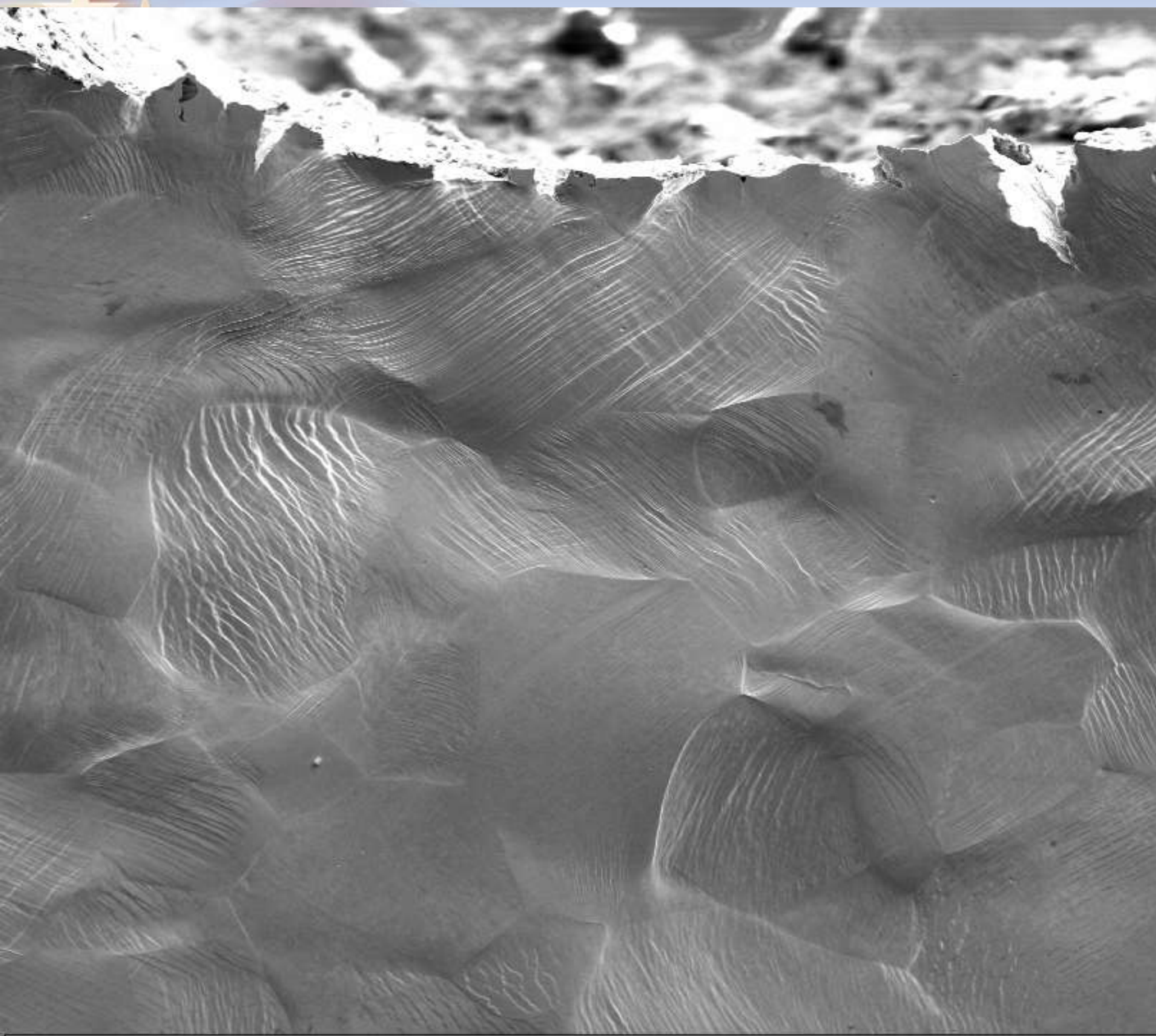
EHT = 10.00 kV

WD = 21.0 mm

Signal A = SE2

File Name = Ta-N1_d1048mV_10.tif

Observing Deformation in Tantalum

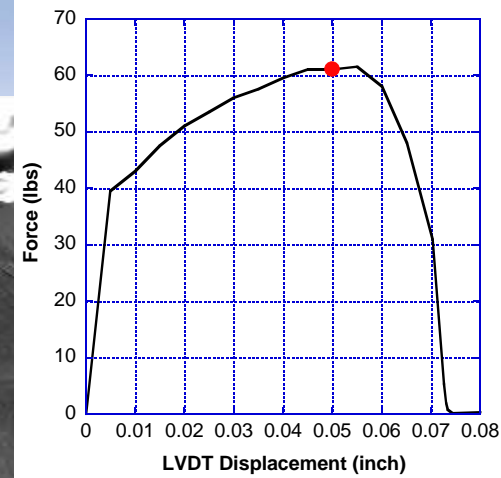
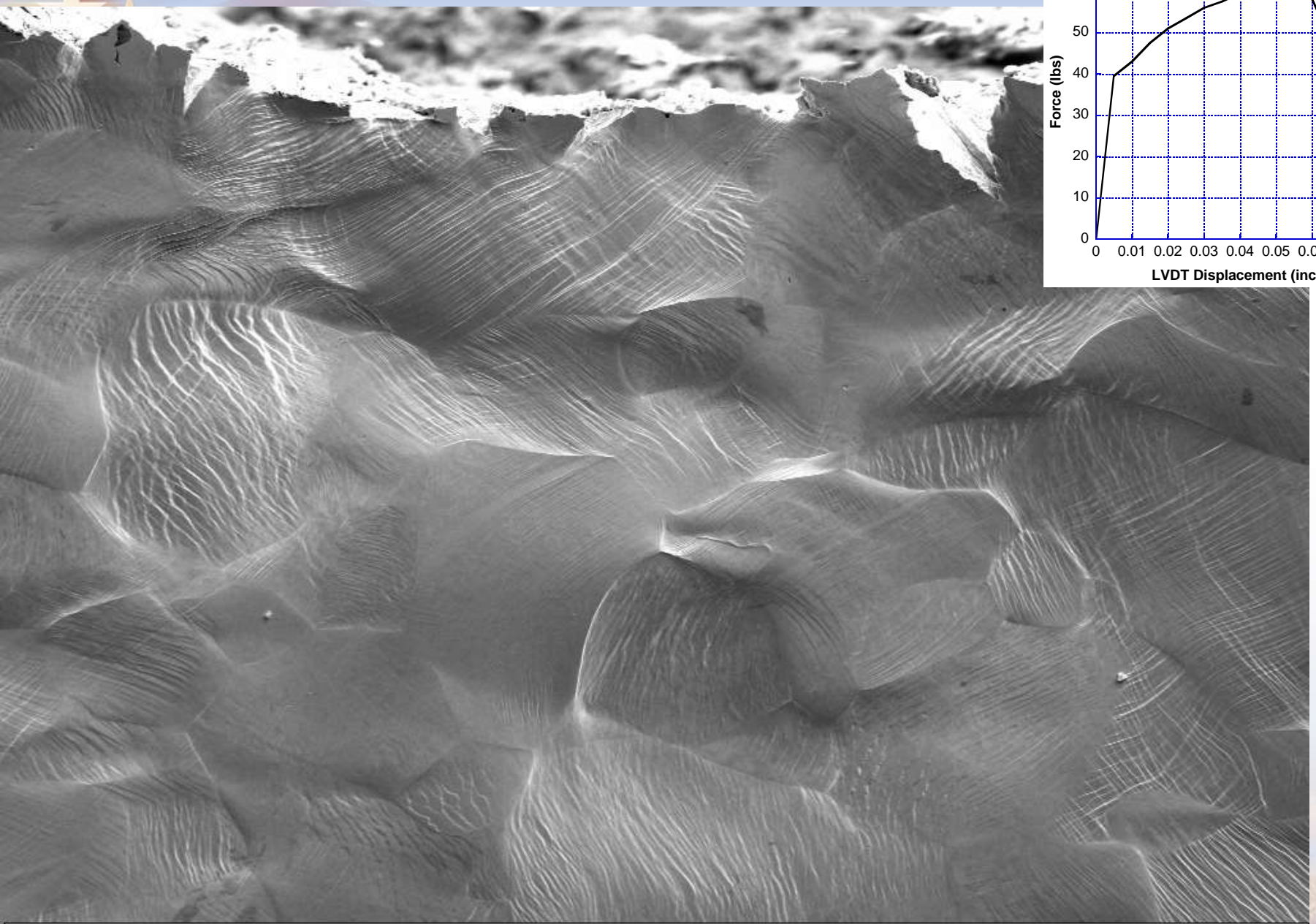


20 μ m

EHT = 10.00 kV WD = 21.1 mm Signal A = SE2

File Name = Ta-N1_d1248mV_11.tif

Observing Deformation in Tantalum

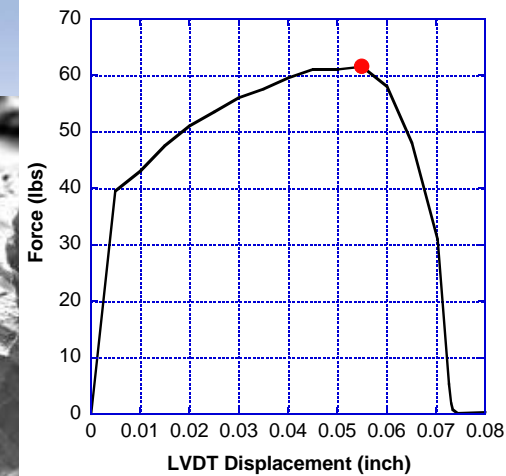
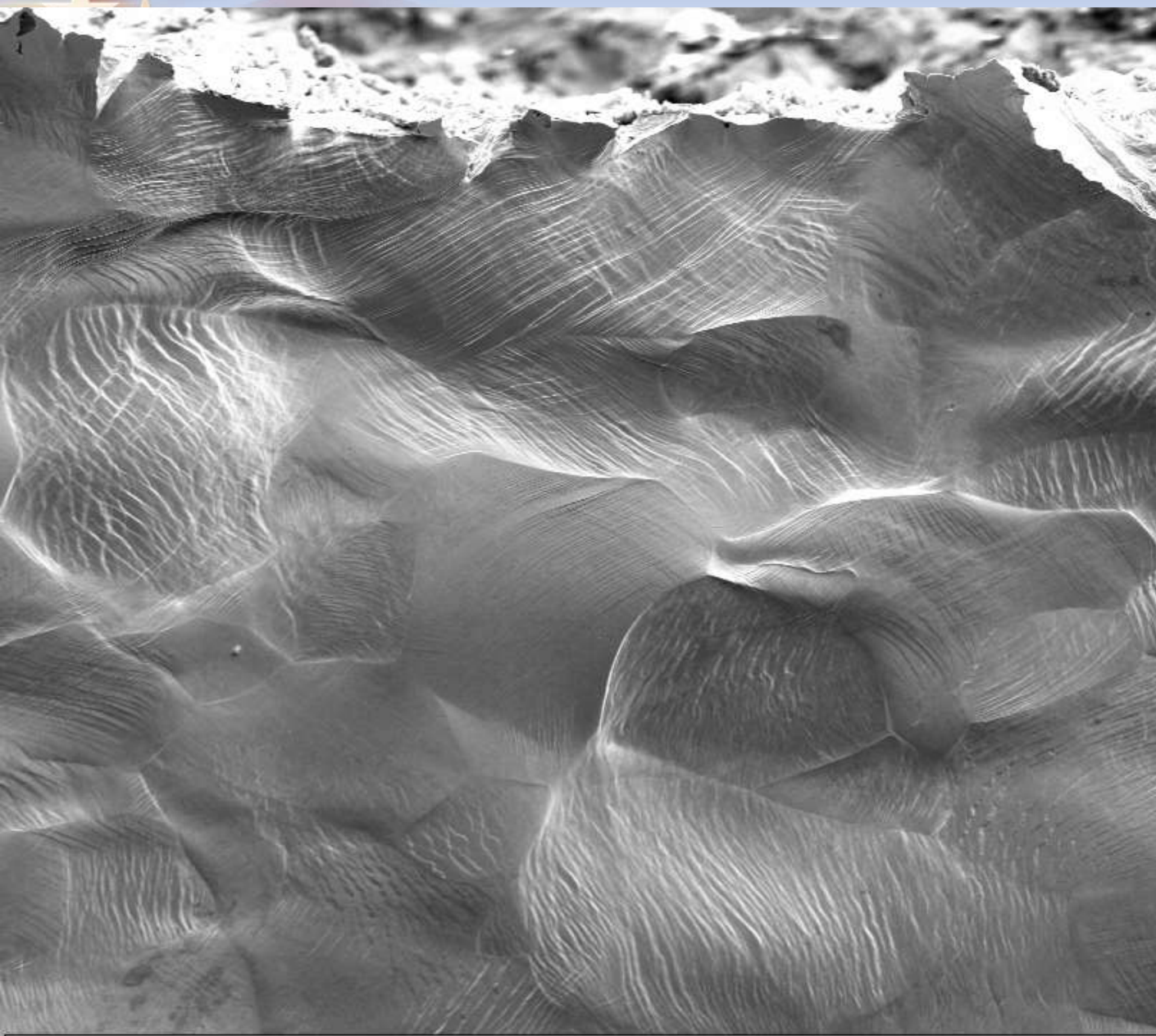


20 μm

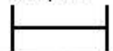
EHT = 10.00 kV WD = 21.1 mm Signal A = SE2

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Observing Deformation in Tantalum



20 μ m



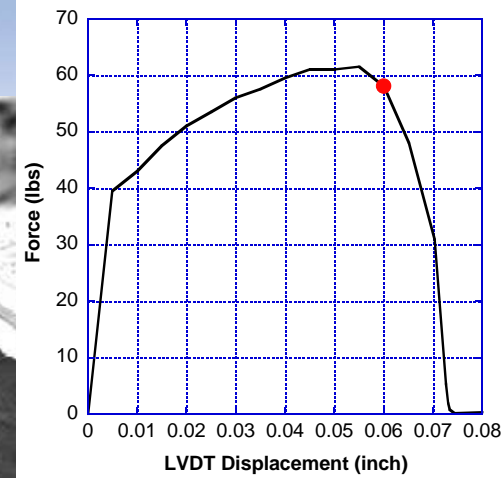
EHT = 10.00 kV

WD = 21.1 mm

Signal A = SE2

File Name = Ta-N1_d1648mV_13.tif

Observing Deformation in Tantalum



20 μ m

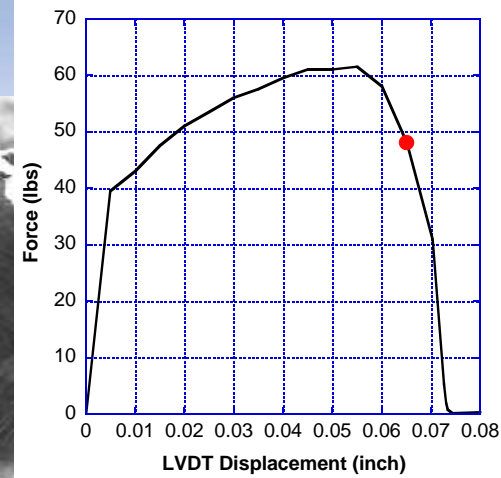
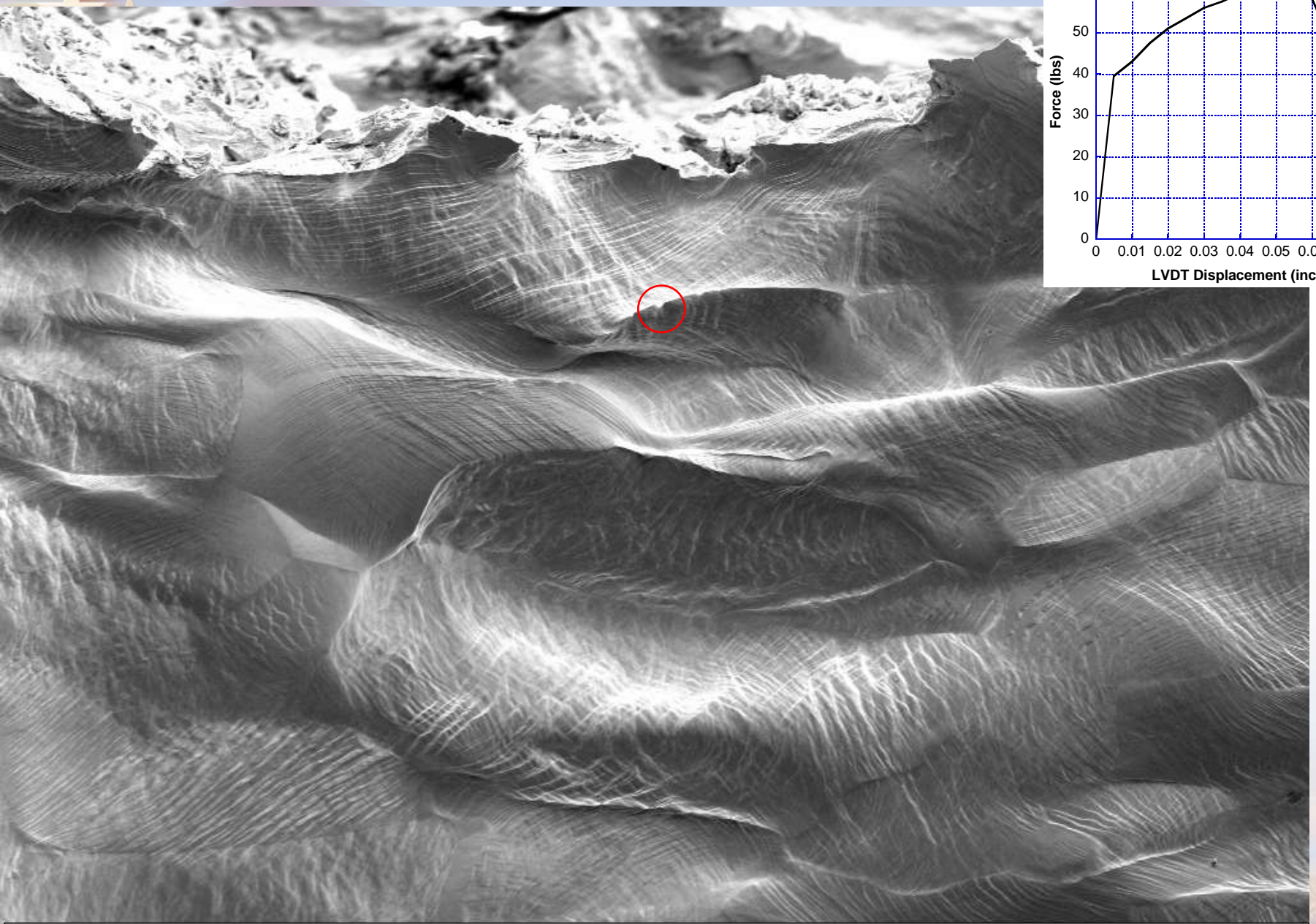
EHT = 10.00 kV

WD = 21.1 mm

Signal A = SE2

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Observing Deformation in Tantalum

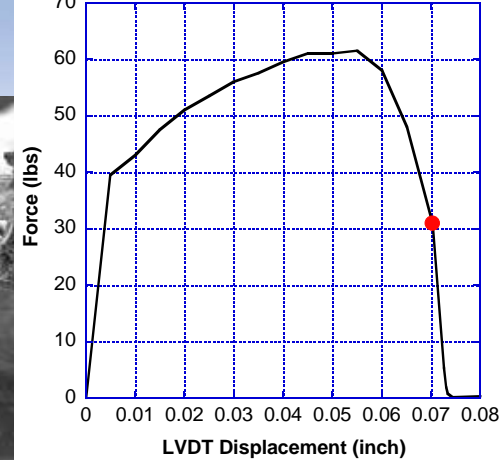
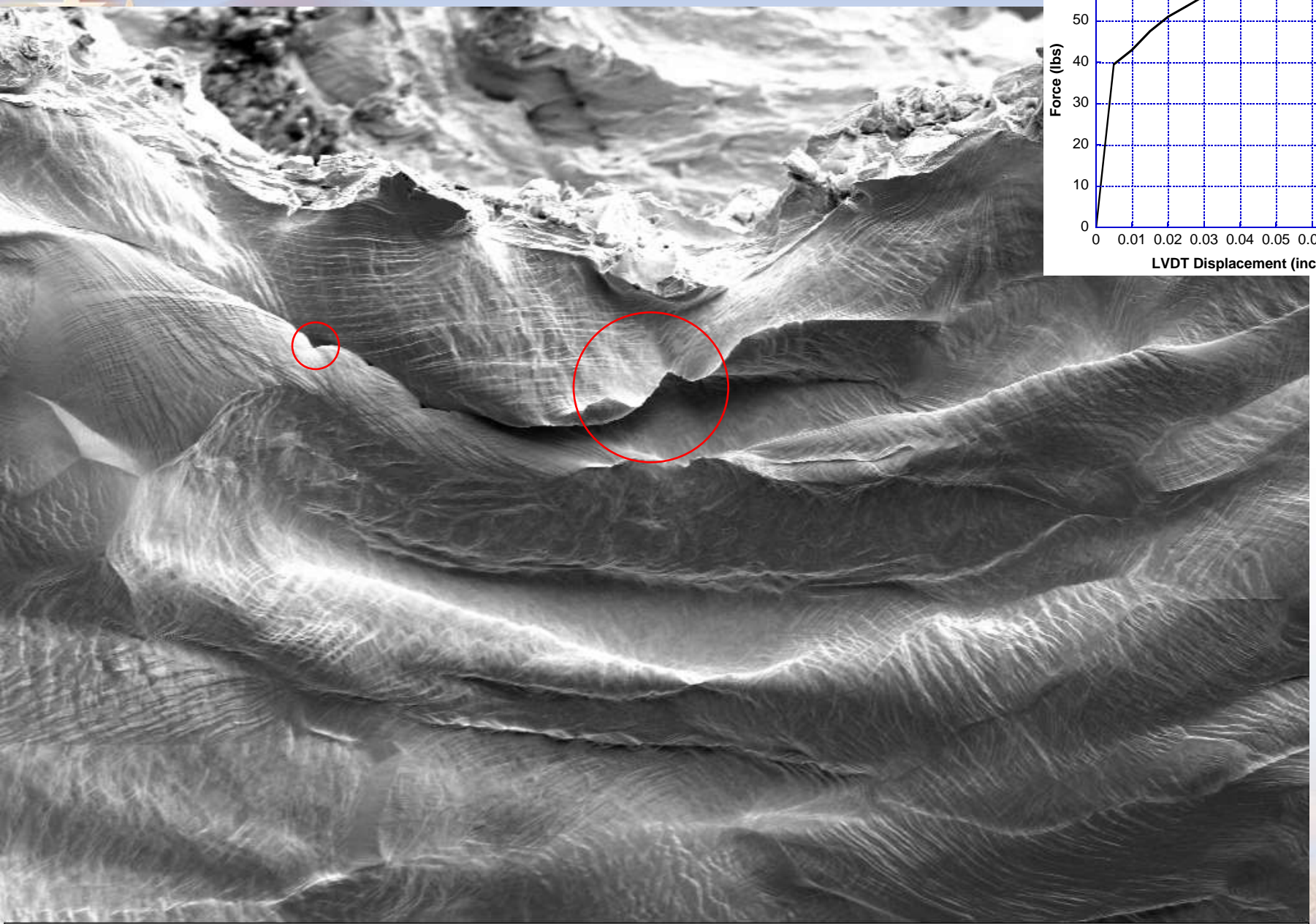


20 μ m

EHT = 10.00 kV WD = 21.2 mm Signal A = SE2

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Observing Deformation in Tantalum



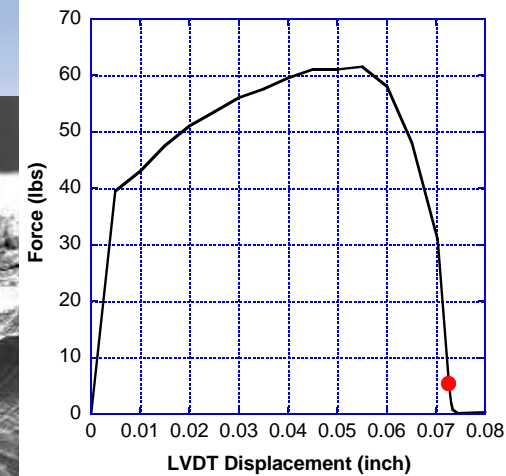
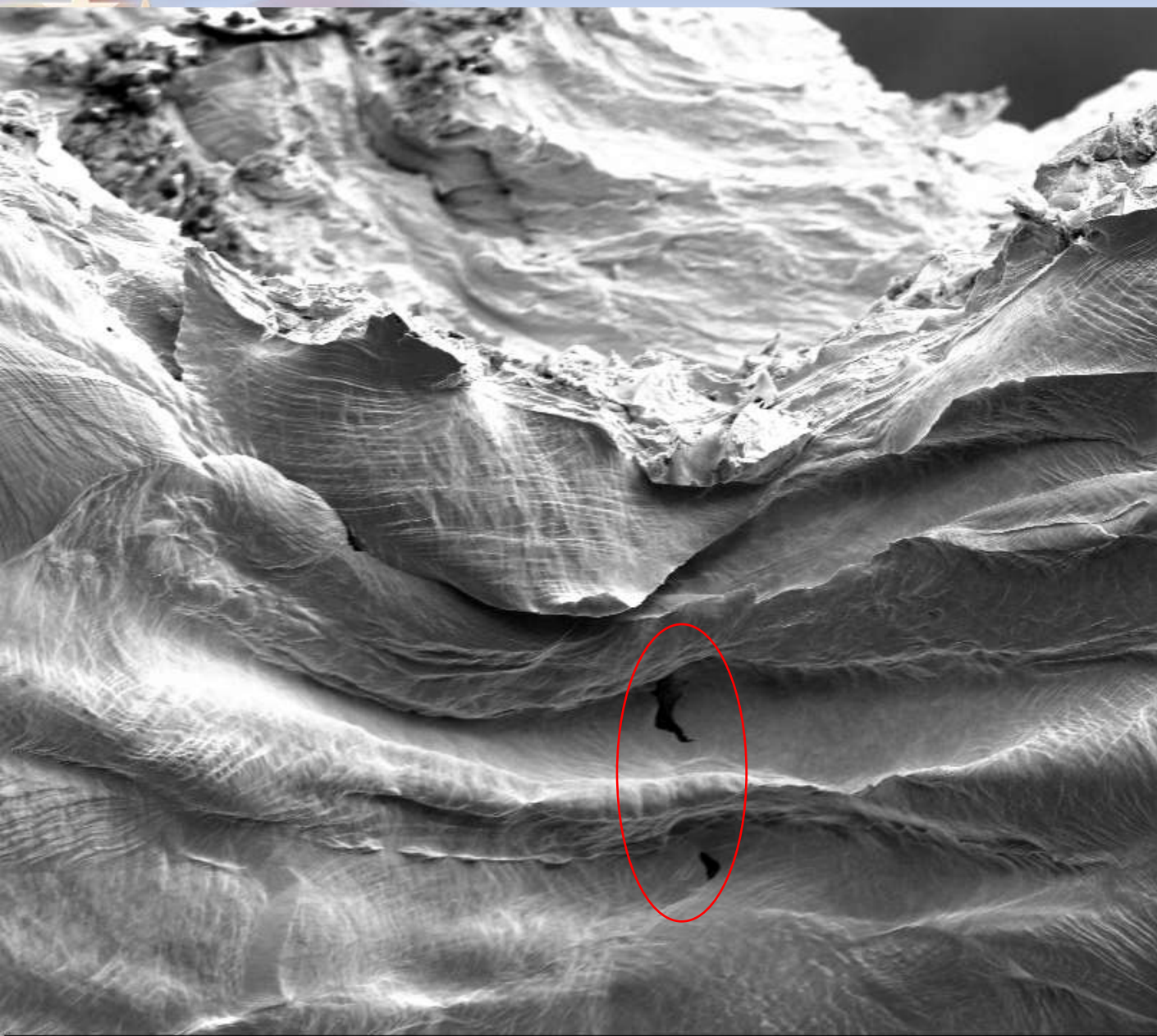
10 μ m

EHT = 10.00 kV WD = 21.2 mm Signal A = SE2

File Name = Ta-N1_d2261mV_17.tif

atories

Observing Deformation in Tantalum



10 μ m

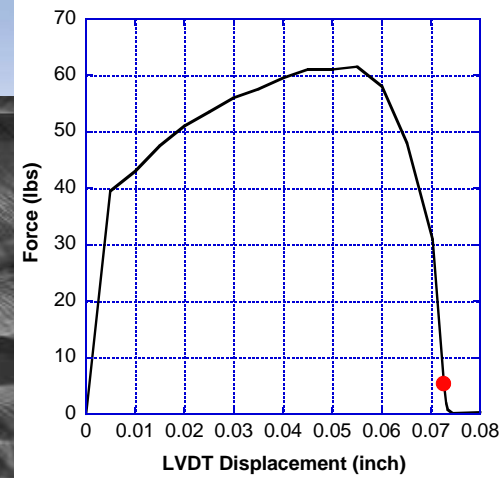
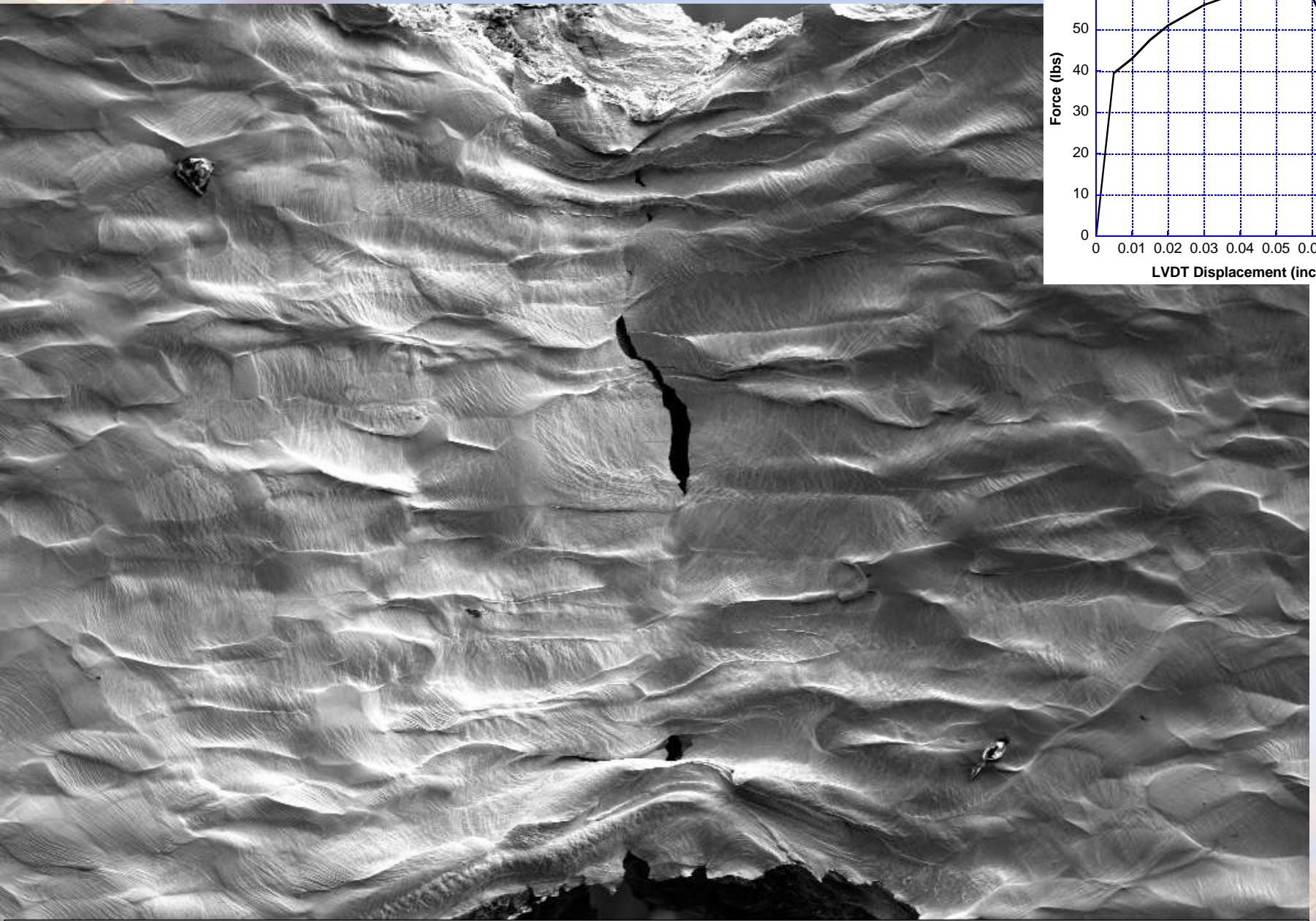
EHT = 10.00 kV

WD = 21.2 mm

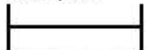
Signal A = SE2

File Name = Ta-N1_d2353mV_19.tif

Observing Deformation in Tantalum



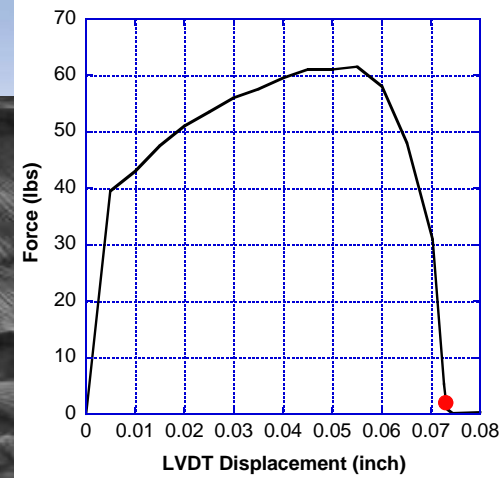
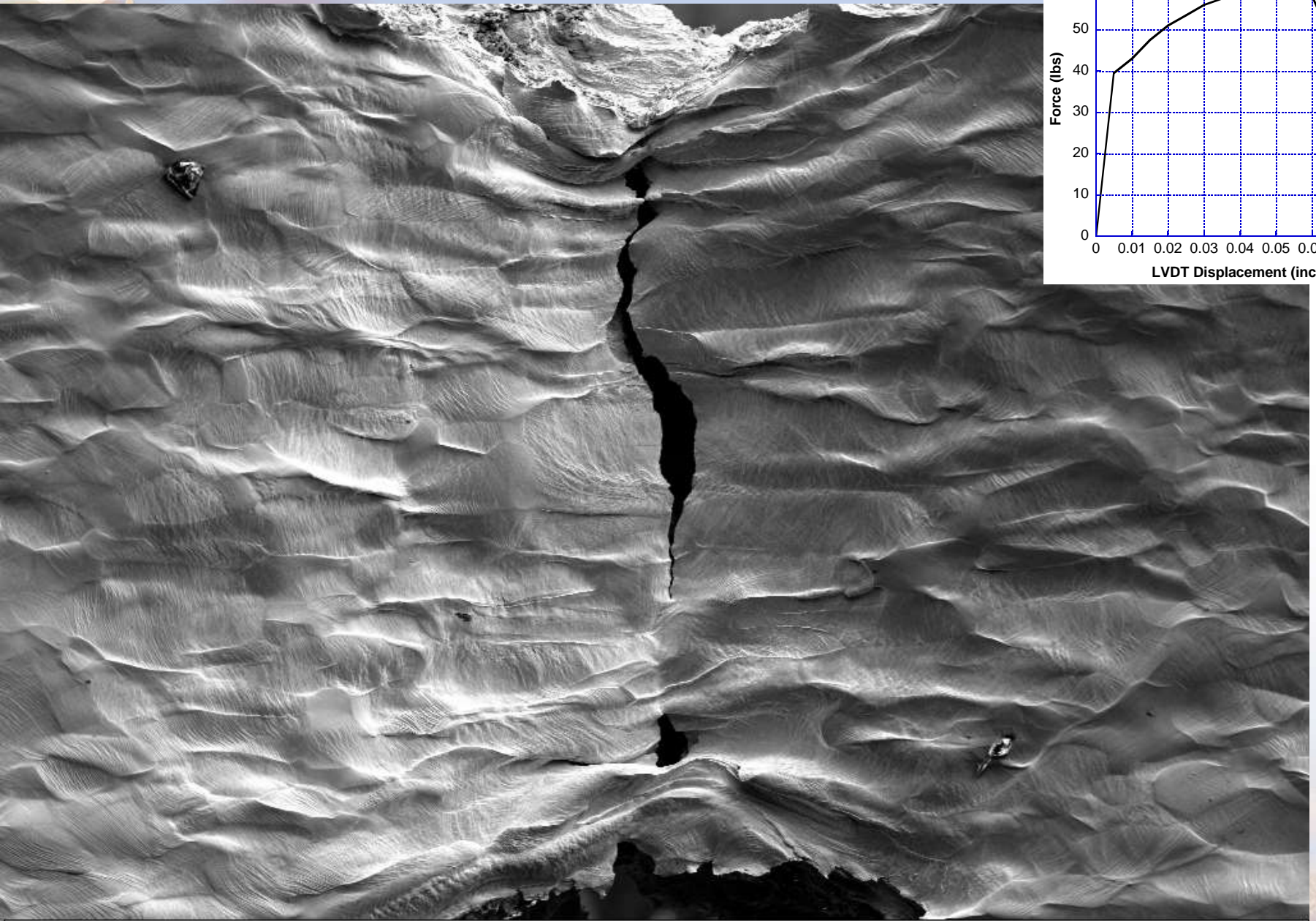
100 μ m



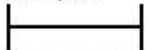
EHT = 10.00 kV WD = 21.4 mm Signal A = SE2

File Name = Ta-N1_d2353mV_21.tif

Observing Deformation in Tantalum



100 μ m



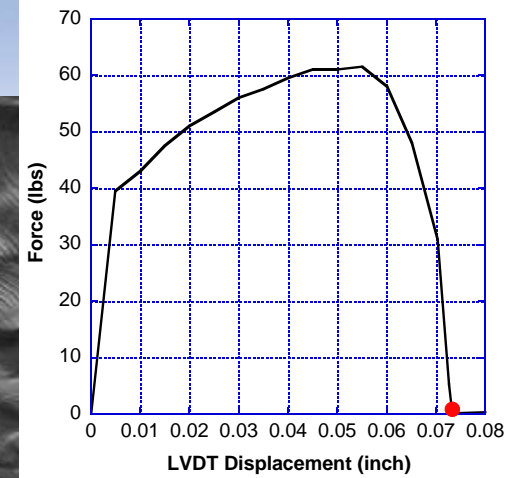
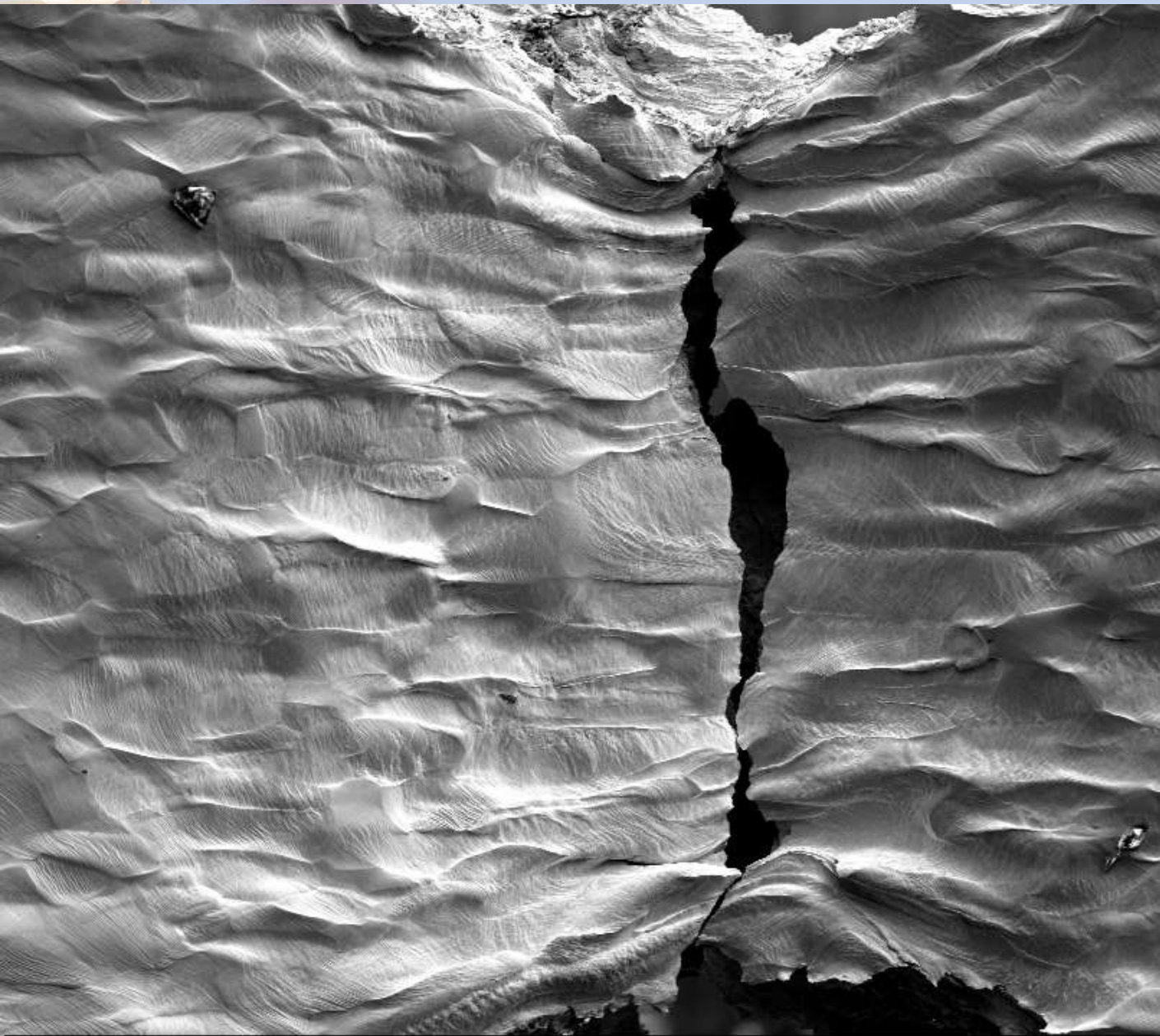
EHT = 10.00 kV

WD = 21.4 mm

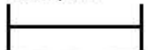
Signal A = SE2

File Name = Ta-N1_d2371mV_22.tif

Observing Deformation in Tantalum



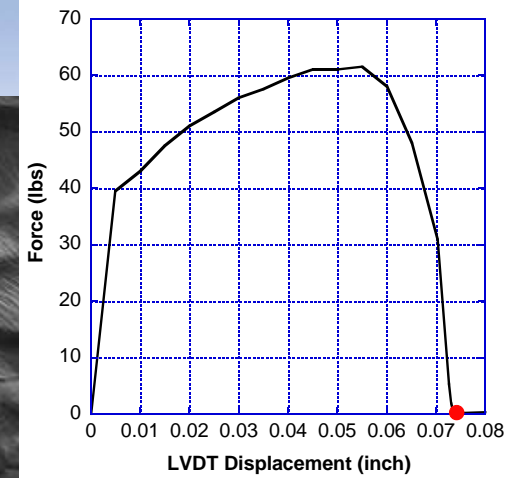
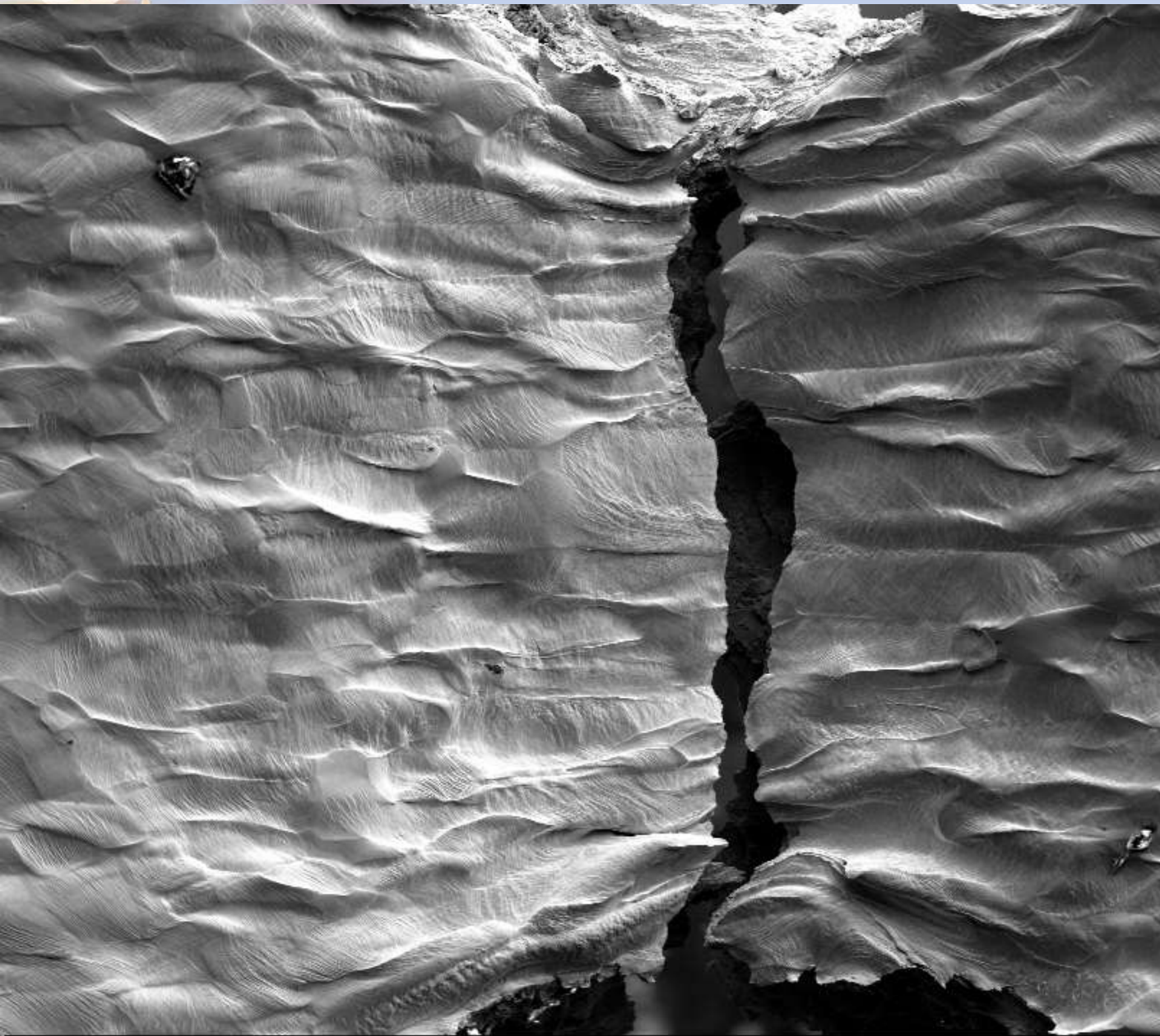
100 μ m



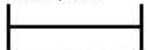
EHT = 10.00 kV WD = 21.4 mm Signal A = SE2

File Name = Ta-N1_d2384mV_23.tif

Observing Deformation in Tantalum



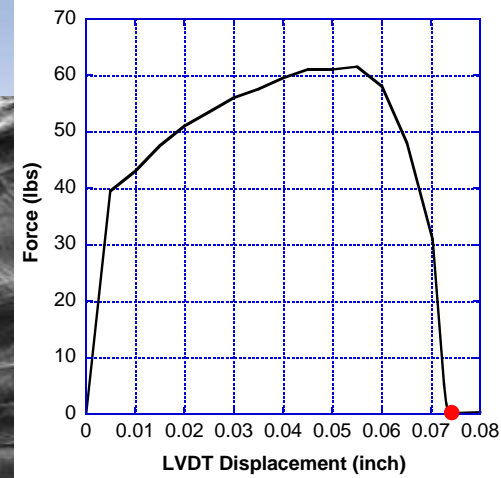
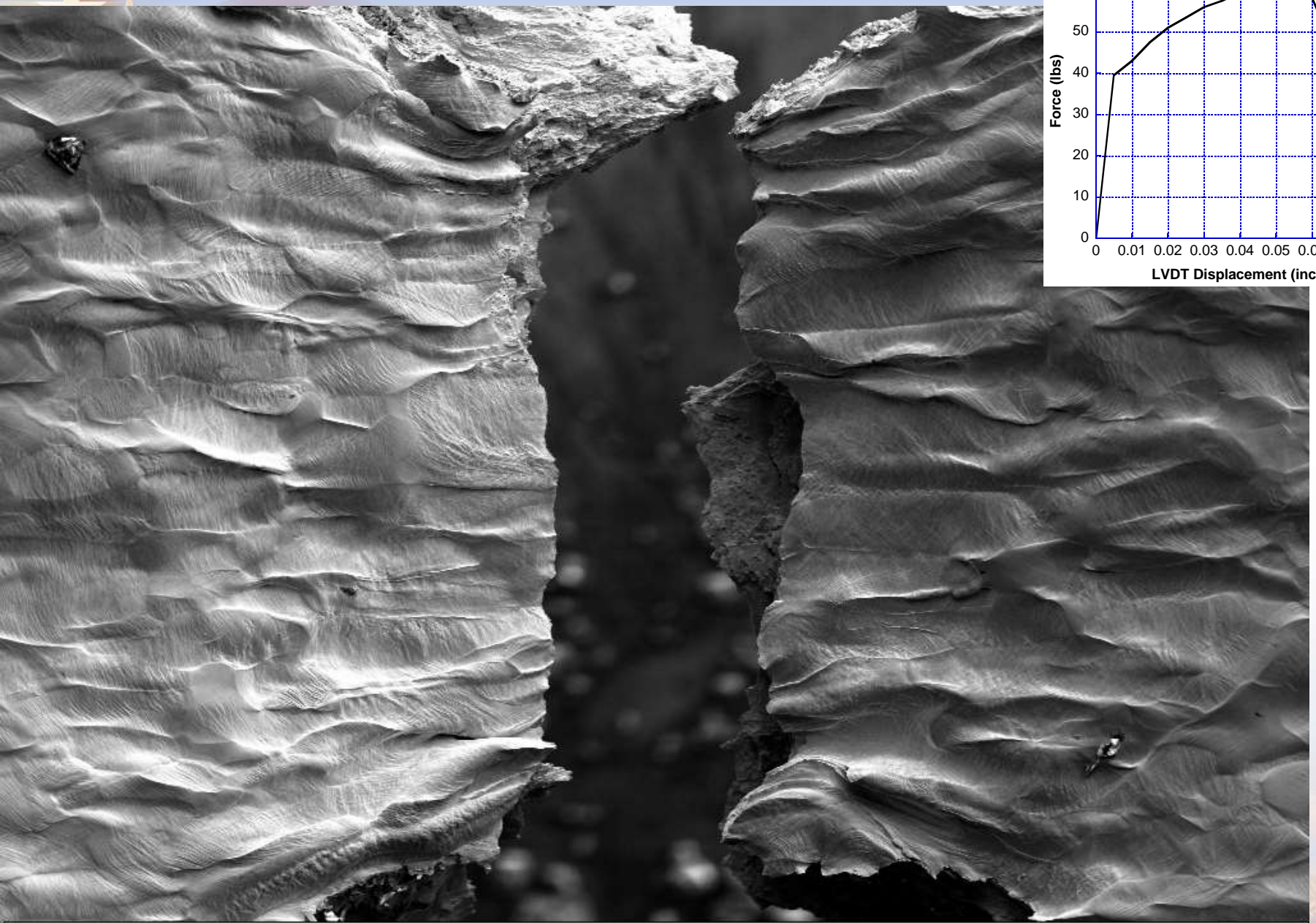
100 μ m



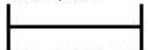
EHT = 10.00 kV WD = 21.4 mm Signal A = SE2

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Observing Deformation in Tantalum



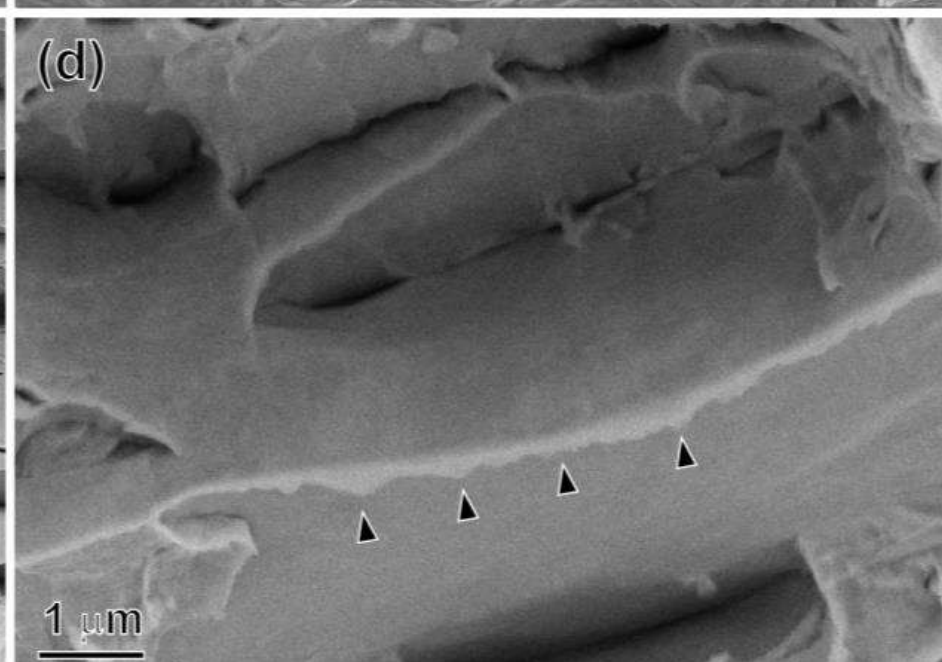
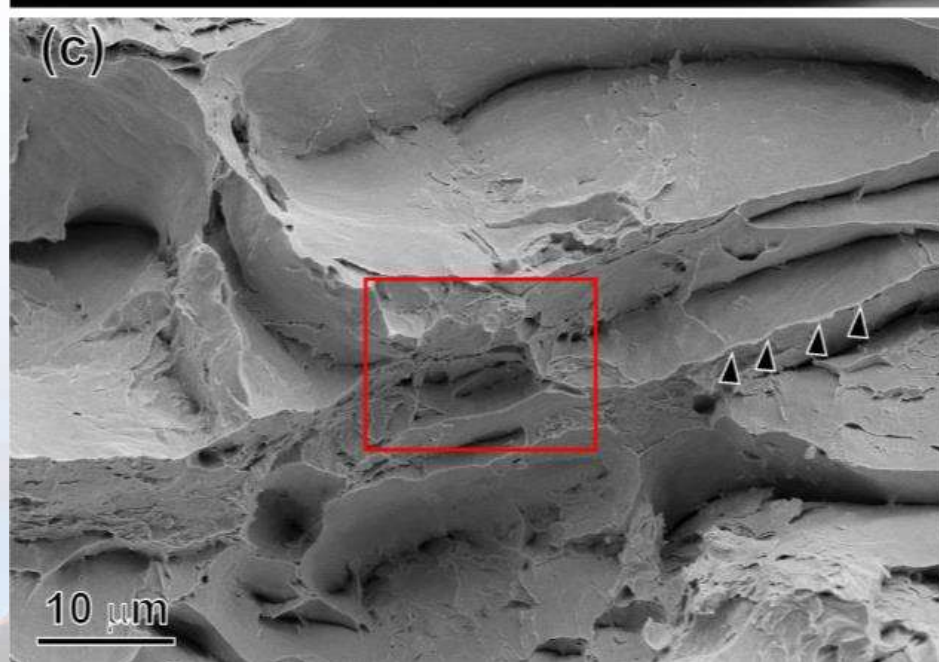
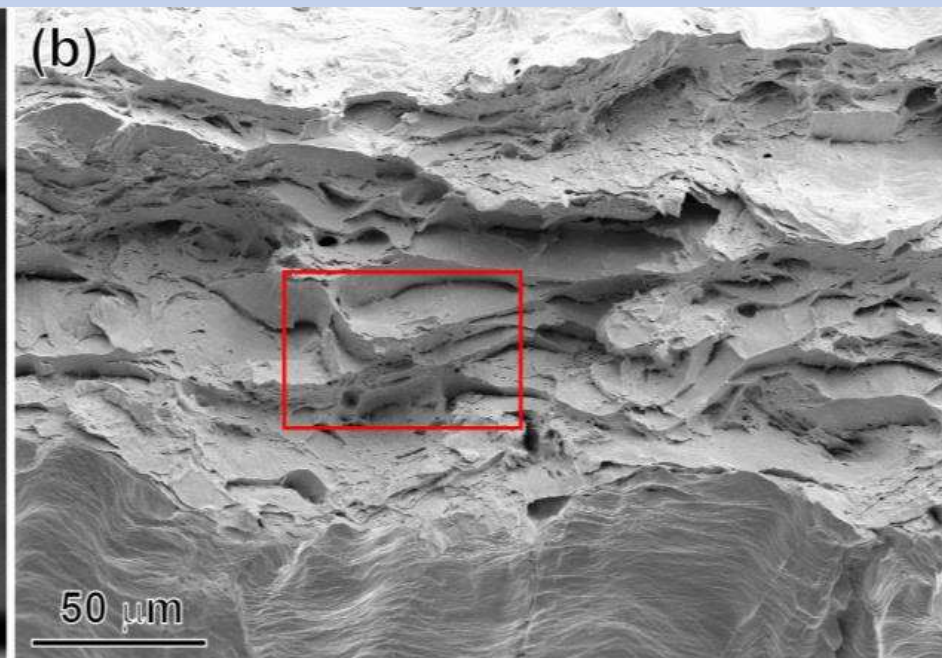
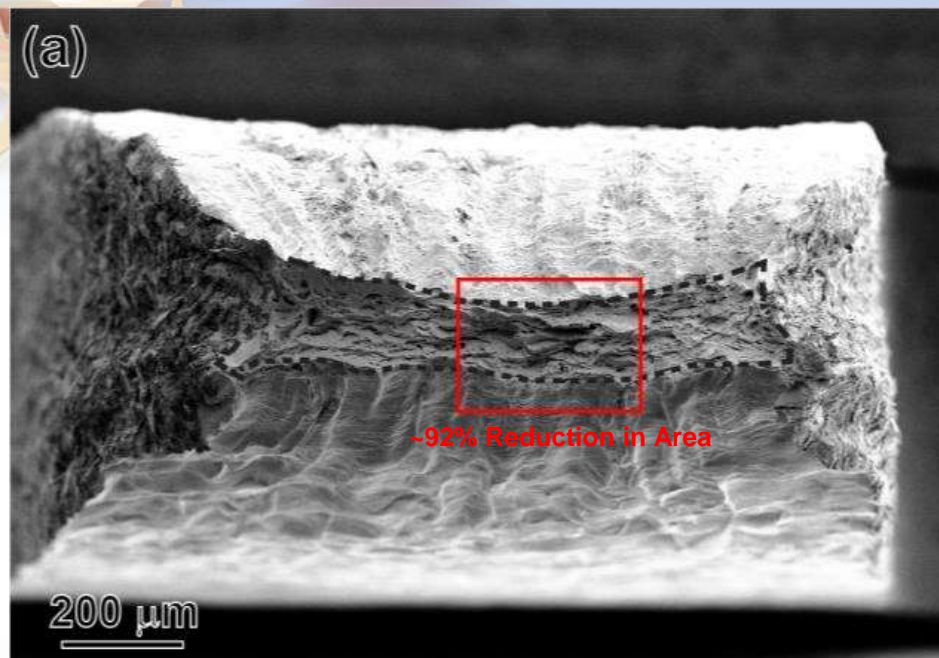
100 μ m



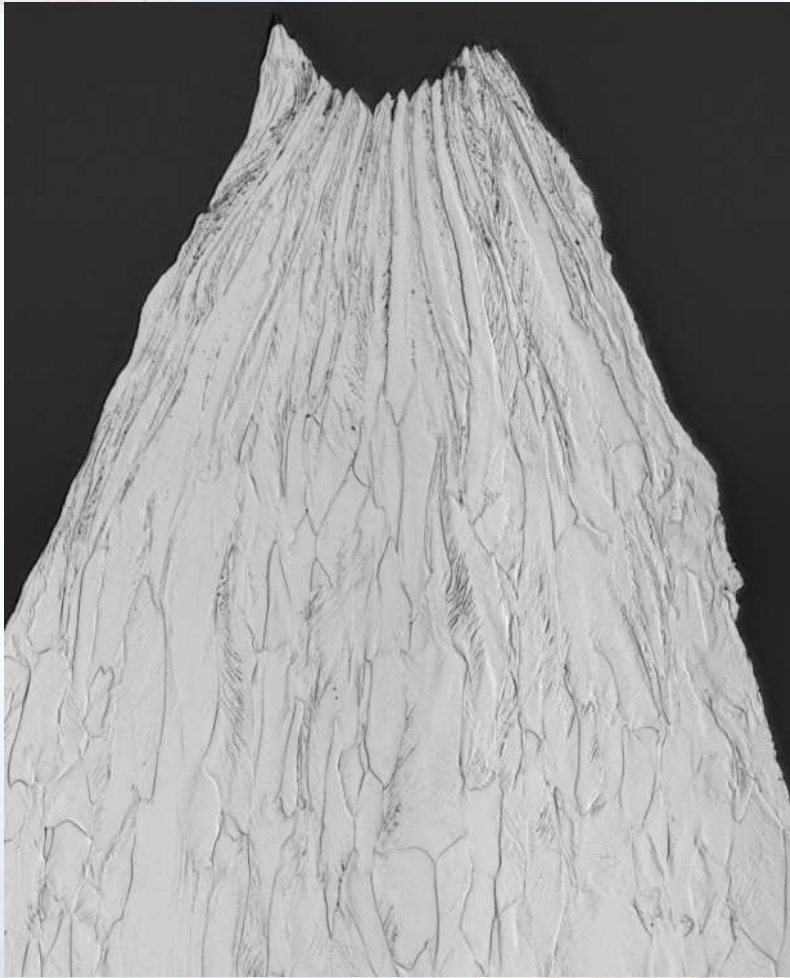
EHT = 10.00 kV WD = 21.4 mm Signal A = SE2

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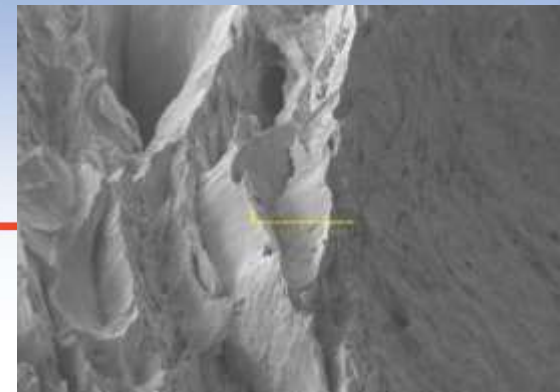
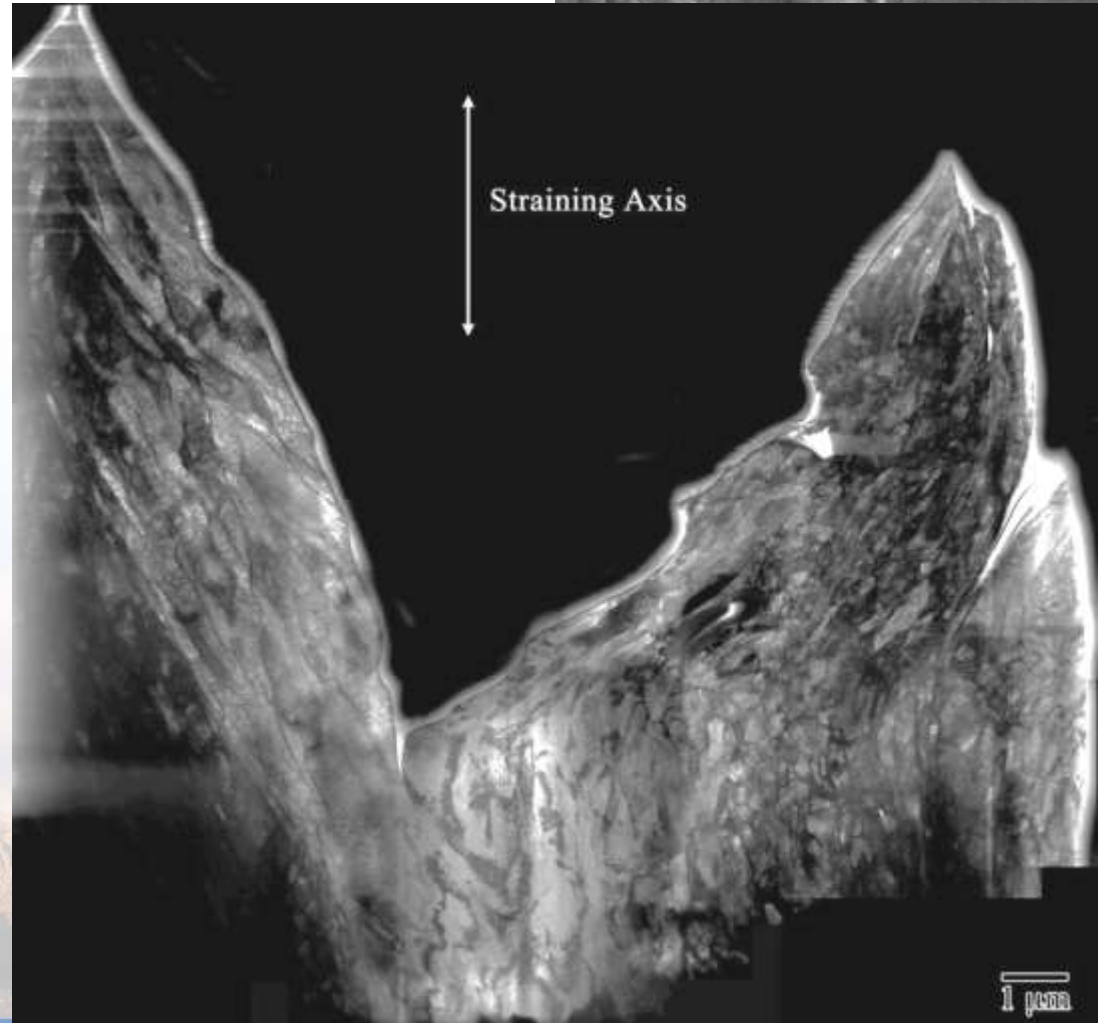
Lack of Classic Ductile Dimple Morphology



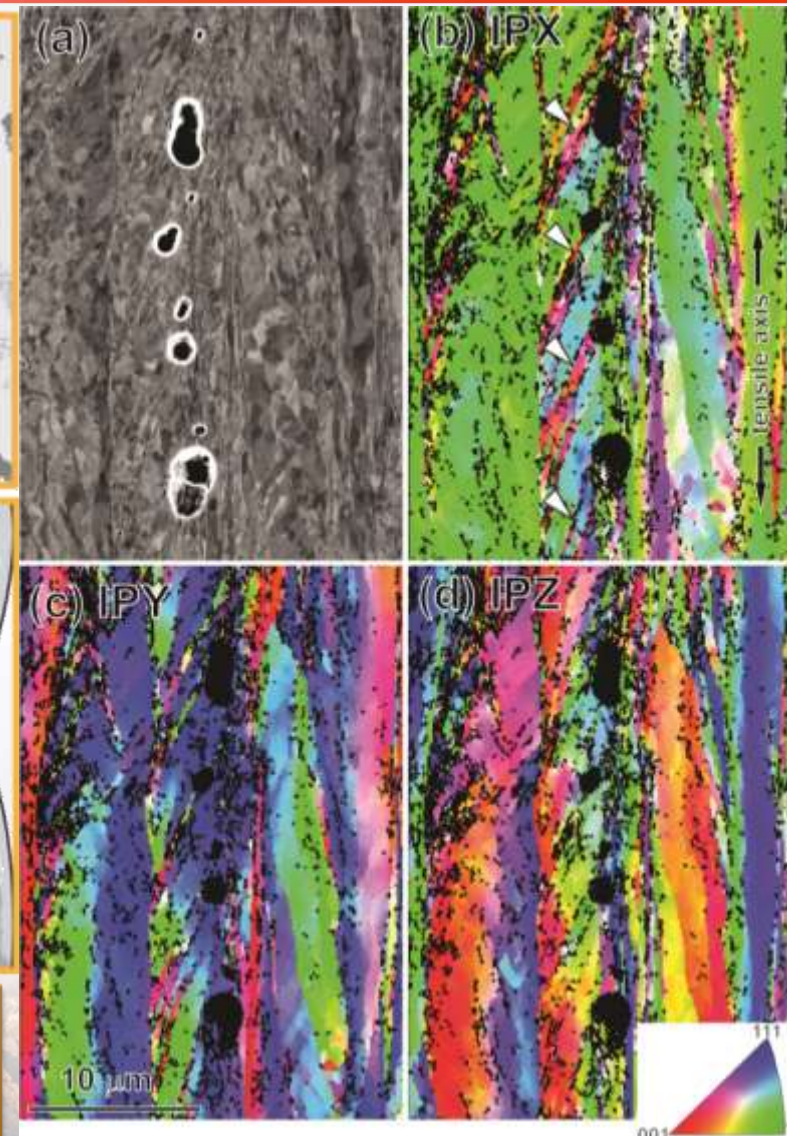
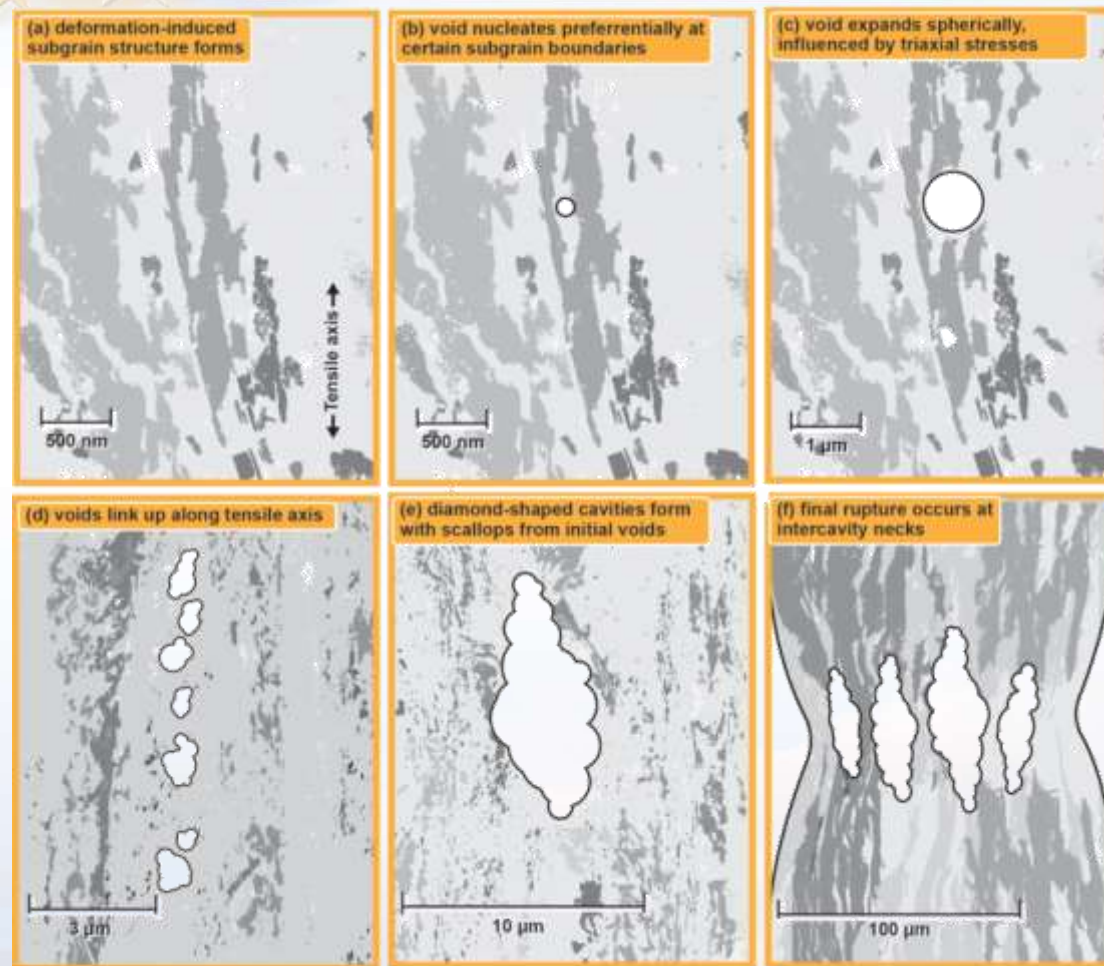
SEM and TEM Cross-section of Fractured Neck in Tantalum



Cross-sectional characterization reveals a complex grain and sub-grain structure in the necked region

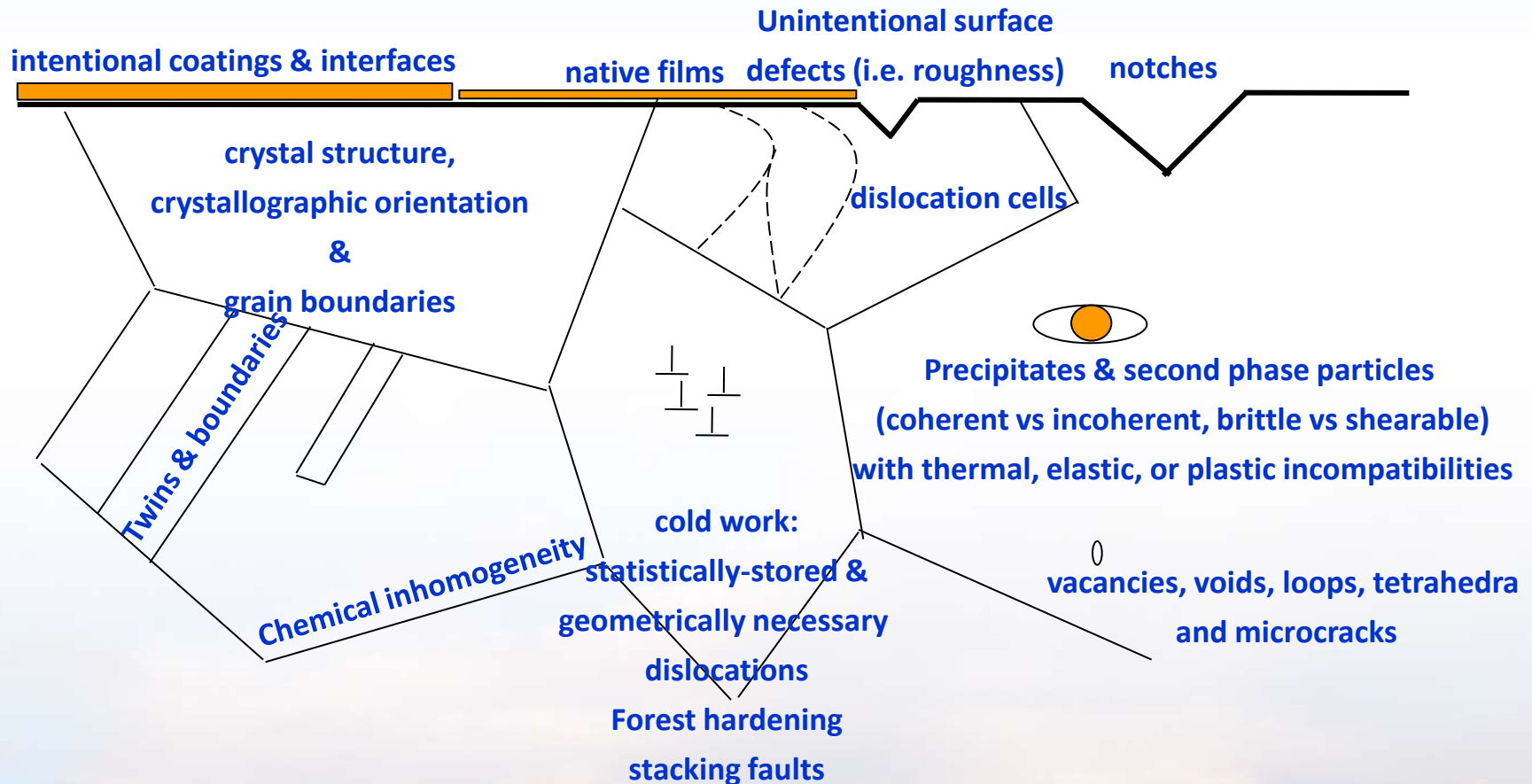


A Schematic of Damage Progression Leading to Catastrophic Fracture



Thus far we've only provide surface information
Can we gain any further insight with 3D characterization to confirm or refute the proposed schematics?

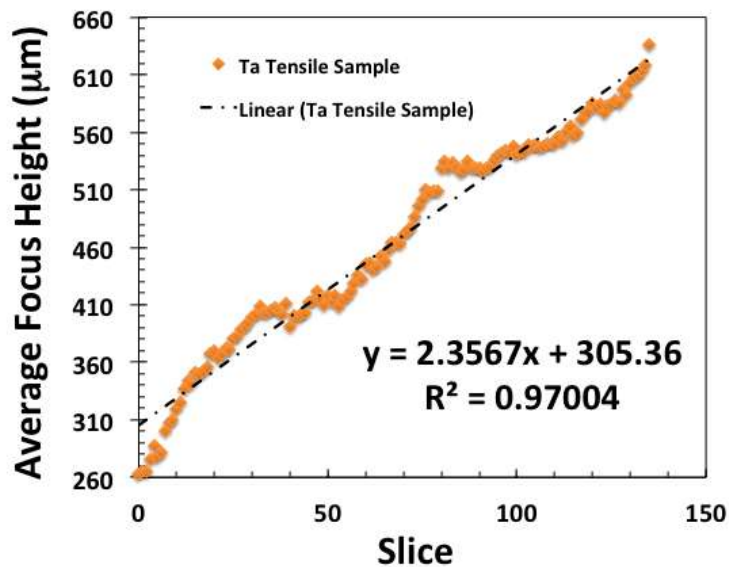
Real Materials Have Complex Features that Influence Failure



The relative importance of each of these factors varies from material to material

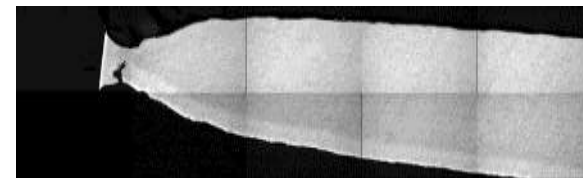


3D RoboMet Polishing Provides Significant Insight



montage: 5 x 2
magnification :
20X

Tantalum tensile void sample



ROBO-MET.3D™
A USB PRODUCT

Image
processing

raw optical
image

8 bit
grayscale

image
cleaning

binarize for
reconstruction

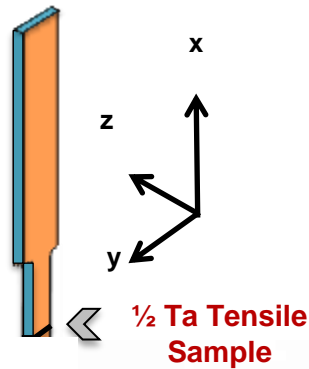
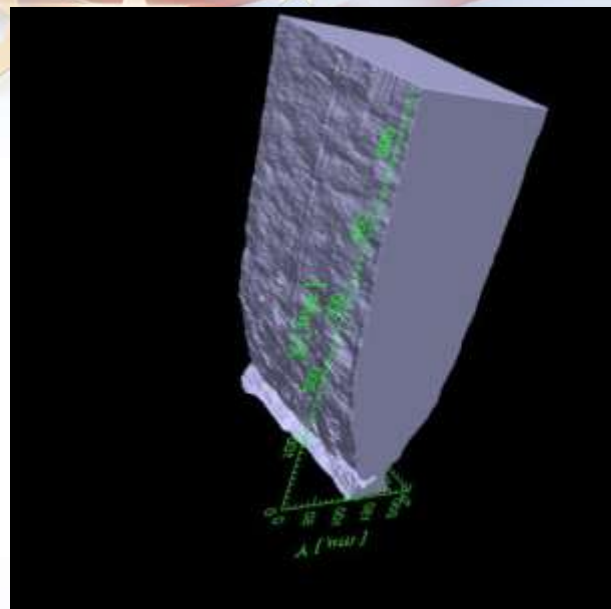
Ta Tensile Voids Serial Sectioning Experiment – June/July 2013

- Completed 135 serial sections at ~ 2.5 microns per slice (total sectioning depth of ~ 340 microns)
- Sample reveals voids at initial cross-section which quickly link to a full crack across the gauge cross-section
 - Crack appears to close at further distances into the gauge section (see end of animation)
- Developed an image segmentation process to binarize the image set for reconstruction and keep fidelity of voids and cracks in gauge section
 - Should have full 3d reconstruction by week's end

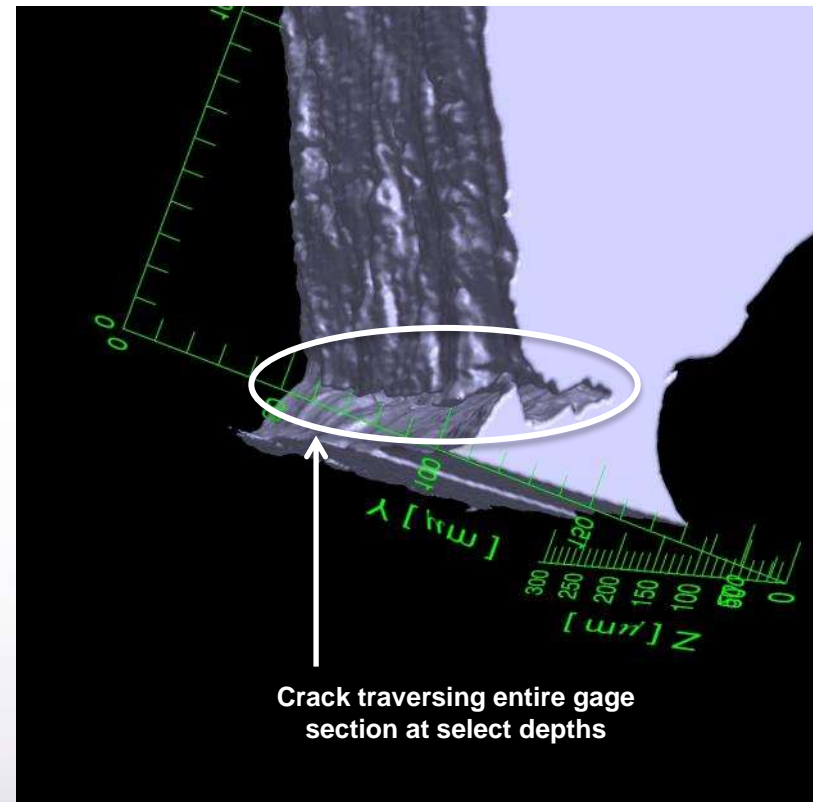


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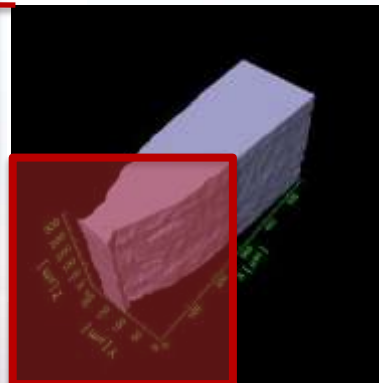
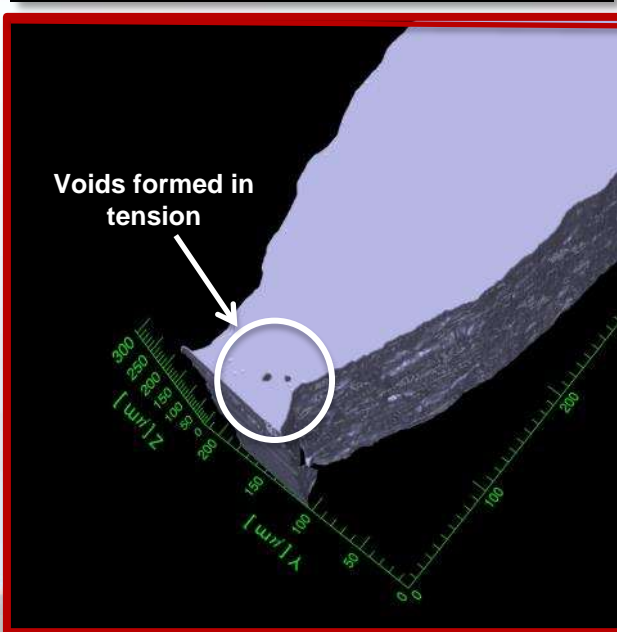
3D Reconstruction Shows Asymmetric Failure



View from final sectioning plane



Voids formed in tension



3D fracture characterization shows a full length crack progressing through only half of the necked region

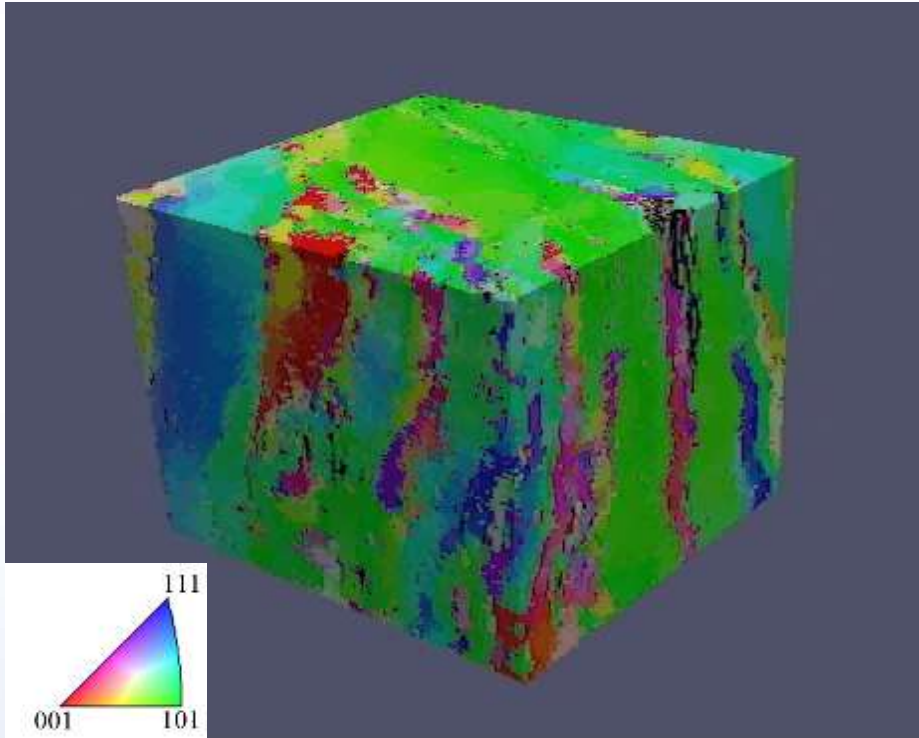
View from initial sectioning plane



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3D EBSD in a Single Subsurface Void

Video of 3-D EBSD reconstruction with IPF colors



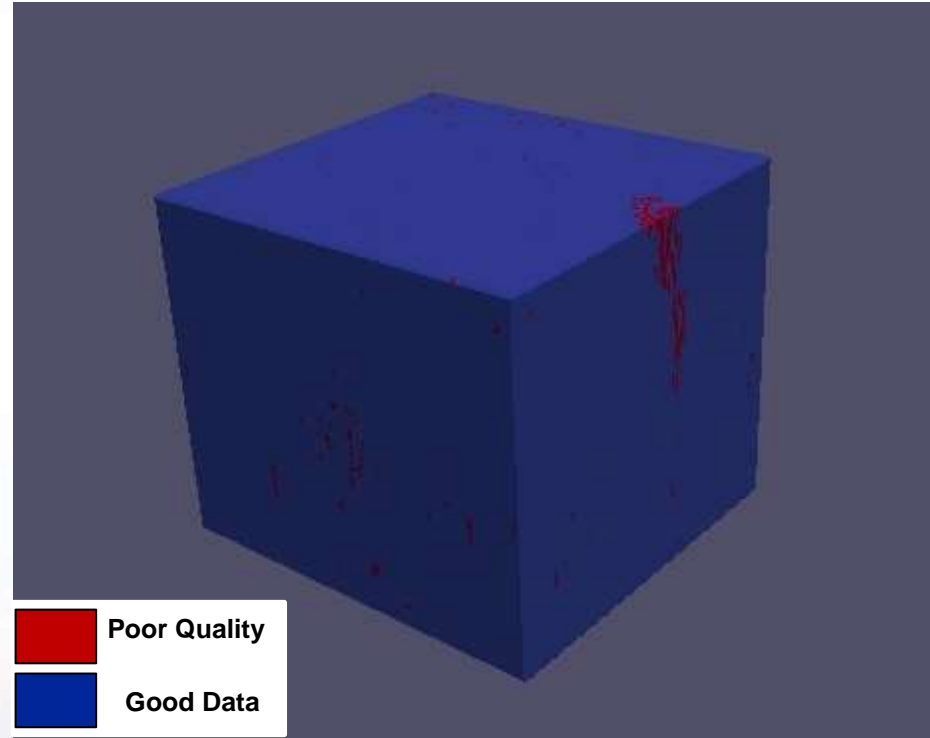
127 slices

Step size: .05 μm

3D EBSD done with Oxford Instruments & DREAM3D EBSD software

3D EBSD highlights the relationship between the local grain boundary location and texture with the voids formed

Video of the registered errors in 3-D EBSD



Filters and Parameters Used in Reconstruction

Multi Threshold (Cell Data): Error=0

Align Sections Misorientation tolerance: 5°

Neighbor Orientation Comparison : 5° & 6 Nearest Neighbor

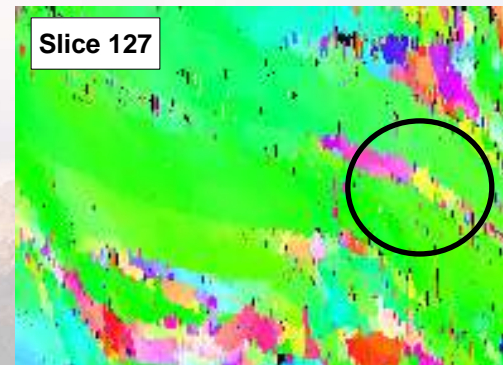
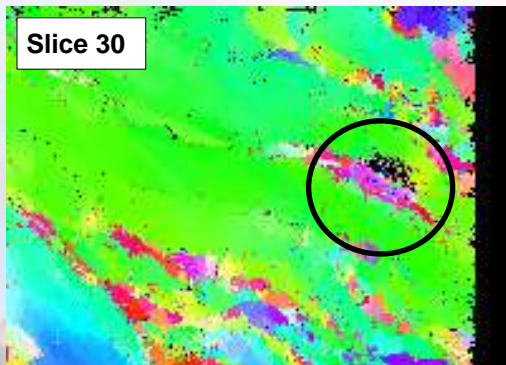
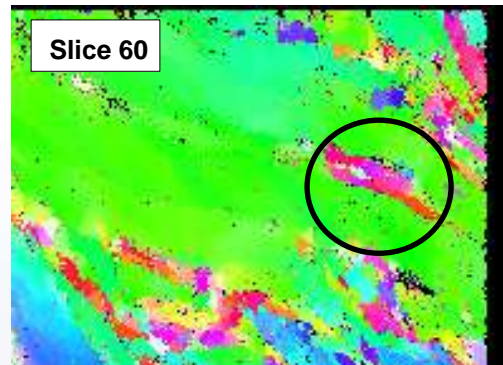
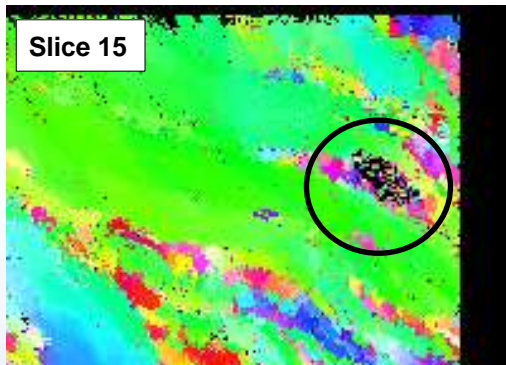
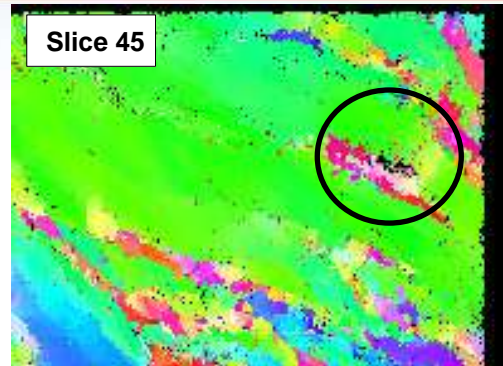
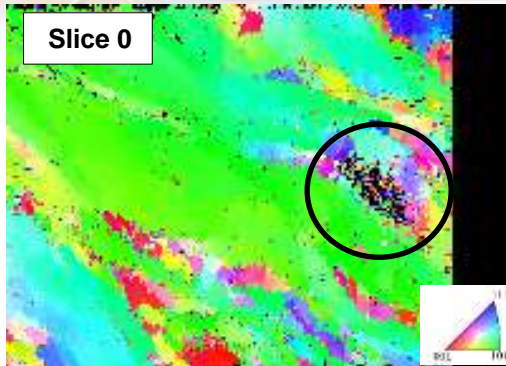
Rename Cell Array from MAD to Confidence Index

Neighbor Orientation Correlation

-Minimum Confidence Index: 0.05

-Cleanup Level: 0

Frame by Frame Analysis of a Single Void



The void starts large, and gradually tapers off.
~50% of the way through the sample it disappears, revealing a sub-grain boundary

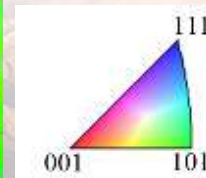
Benefits

- 3D visualization of the local region
- Grain orientation through thickness
- Clearer understanding of the depth and tapering of voids

Limits

- Rapid scans result in high error
- Processing software is still under development
- Full capabilities still being explored

The noise and shape of the void are suspected to be artifacts of the current data processing



Summary

In-situ Ta straining experiments

- Ductile failure is a stochastic phenomenon
- Even average behavior for ductile fracture is difficult to predict
- Crystal plasticity models may provide a pathway to assess microstructural effects on ductile fracture. To that end, a BCC Crystal plasticity model is under development for Ta.
- In-situ mechanical testing provides a method to both validate crystal plasticity models and observe fracture processes for the development of practical microstructural-scale failure models.

Current status on the 3D characterization

- Feasible at Optical Microscopy Level
 - Demonstrate asymmetric failure
- Feasible at EBSD level of a single void
 - Demonstrate the importance of sub-grain boundaries in void location

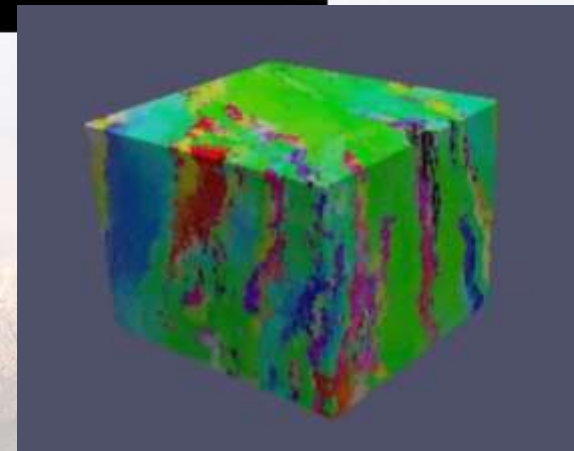
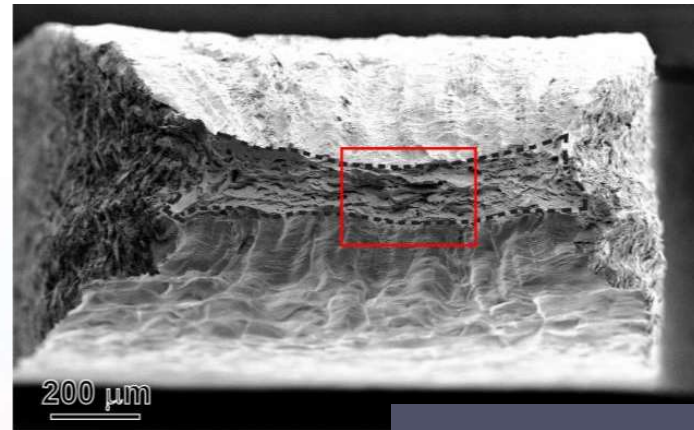
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